3.2W I²S Input Mono Class-D Audio Amplifier with Effortless Boot and Ultra-Low Quiescent Current

1 General Description

The RT9123 is a mono Class-D amplifier that features high efficiency and performance. In addition to I²C control, the RT9123 also features a "HW Control Mode" selection for the I²S/Time-Division Multiplexed (TDM) interface. This mode simplifies the amplifier driver, as it does not require I²C commands to turn on or off the device. The digital audio interface supports various formats, including I²S, left-justified, right-justified, and 8-channel TDM formats.

The recommended junction temperature range is –40°C to 125°C, and the ambient temperature range is –40°C to 85°C.

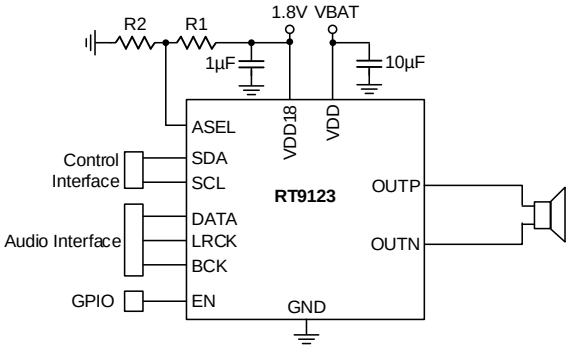
2 Applications

- Smartphones
- Tablets
- Personal Media Players
- Portable TVs
- Gaming Devices
- Cameras

3 Features

- **Class-D Speaker AMP**
  - **3.2W Output Power @ 4Ω Load, THD < 10%**
  - **8μV Output Noise**
  - **Low Shutdown Current**
  - **50μA Quiescent Current in Silence Mode**
  - **Add Dynamic Range Enhancement (DRE) to Reduce Output Noise**
  - **Spread Spectrum Frequency**
  - **Fast Turn-On Time: 1ms**
  - **Support HW Control Mode without Driver and I²C Control**
  - **Silence Data Detection**
  - **Beep Function**
- **Digital Audio Interface**
  - **Support I²S, Left-Justified, Right-Justified, and TDM**
  - **Support 8/16/20/24/32 Bit Data Length and 8kHz to 96kHz Sample Rate**
- **Digital Volume Control**
- **Clipping Reduce Gain Control**
- **Protection**
  - **OCP: Detect High Current Levels to Disable the Analog Blocks for 100ms**
  - **VDD UVP: Disable the Analog Blocks when the Battery Voltage Falls Below 2.2V**
  - **VDD18 UVP: Disable the Analog Blocks when the Battery Voltage Falls below 1.4V**
  - **OTP: Disable the Analog Block when the IC Temperature Exceeds 150°C**

4 Simplified Application Circuit



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5 Ordering Information

RT9123□□-□□□

Pin 1 Orientation
(2): Quadrant 2, Follow EIA-481 for WL-CSP-14B 1.81x1.1 (BSC)
Empty: Quadrant 1 for WDFN-12L 3x3

Functional Option
(Refer to Version Table)

Package Type(1)
WSC: WL-CSP-14B 1.81x1.1 (BSC)
QW: WDFN-12L 3x3 (W-Type)
(Exposed Pad: Option 1)

Lead Plating System
G: Richtek Green Policy Compliant(2)
(For WDFN-12L 3x3 Only)

Note 1.

- Marked with (1) indicated: Compatible with the current requirements of IPC/JEDEC J-STD-020.
- Marked with (2) indicated: Richtek products are Richtek Green Policy compliant.

6 RT9123 Version Table

(Note 2)

RT9123 Current Release Version			RT9123 Customized Setting		
Part Number	**Spread Spectrum Reg D_FSS_EN 0x04 [2]**	**Volume Ramp Reg SKIP_RAMP 0x04 [8]**	**Clipping AGC Reg CLIP_AGC_EN 0x04 [0]**	**Silence Detection Reg SIL_DET_EN 0x04 [14]**	**Audio Format (I^2S/Left-Justify)**
RT9123WSC-2C(2) RT9123GQW-2C	ON 0x04 [2] = 1	ON (5.3ms) 0x04 [8] = 0	OFF 0x04 [0] = 0	ON 0x04 [14] = 1	I^2S
RT9123WSC-2E(2) RT9123GQW-2E	ON 0x04 [2] = 1	OFF (1ms) 0x04 [8] = 1	OFF 0x04 [0] = 0	ON 0x04 [14] = 1	I^2S
RT9123WSC-A4(2) RT9123GQW-A4	OFF 0x04 [2] = 0	ON (5.3ms) 0x04 [8] = 0	OFF 0x04 [0] = 0	ON 0x04 [14] = 1	I^2S
RT9123WSC-A6(2) RT9123GQW-A6	OFF 0x04 [2] = 0	OFF (1ms) 0x04 [8] = 1	OFF 0x04 [0] = 0	ON 0x04 [14] = 1	I^2S

Note 2. This version table is customized for customer use in HW mode.

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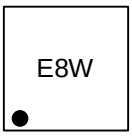
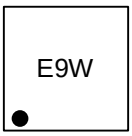
7 Marking Information

RT9123WSC-2C(2)



E8: Product Code
W: Date Code

RT9123WSC-2E(2)



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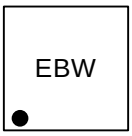
W: Date Code

RT9123WSC-A4(2)

EA: Product Code
W: Date Code

RT9123WSC-A6(2)



EB: Product Code
W: Date Code

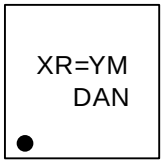
RT9123GQW-2C

XP=: Product Code
YMDAN: Date Code

RT9123GQW-2E

XQ=: Product Code
YMDAN: Date Code

RT9123GQW-A4



XR=: Product Code
YMDAN: Date Code

RT9123GQW-A6

XS=: Product Code
YMDAN: Date Code

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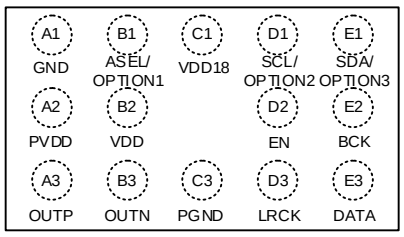
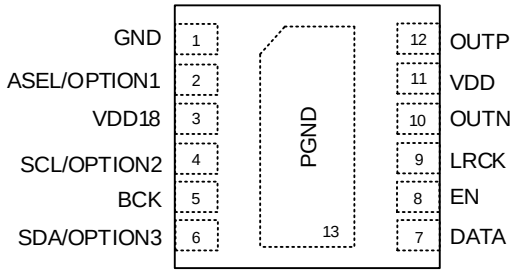
8 Pin Configuration

(TOP VIEW)



WL-CSP-14B 1.81x1.1 (BSC)



WDFN-12L 3x3

9 Functional Pin Description

Pin No.		Pin Name	Type	Pin Function
WL-CSP-14B 1.81x1.1 (BSC)	WDFN-12L 3x3			
A1	1	GND	G	Ground.
A2	--	PVDD	P	Supply for the Class-D amplifier.
A3	12	OUTP	O	Positive Class-D amplifier output.
B1	2	ASEL/OPTION1	I	Address/gain selection (5 steps).
B2	11	VDD	P	Supply for analog power.
B3	10	OUTN	O	Negative Class-D amplifier output.
C1	3	VDD18	P	Supply for IO power.
C3	13	PGND	G	Power ground.
D1	4	SCL/OPTION2	I	I^2C clock signal input/channel selection.
D2	8	EN	I	Chip enable pin.
D3	9	LRCK	I	I^2S date frame signal input.
E1	6	SDA/OPTION3	I/O	I^2C data signal input/channel selection.
E2	5	BCK	I	I^2S bit clock signal input.
E3	7	DATA	I	I^2S data signal input.

9.1 IO Type Definition

- P: Power Pin
- G: Ground Pin
- O: Output Pin
- I: Input Pin
- I/O: Input/Output Pin

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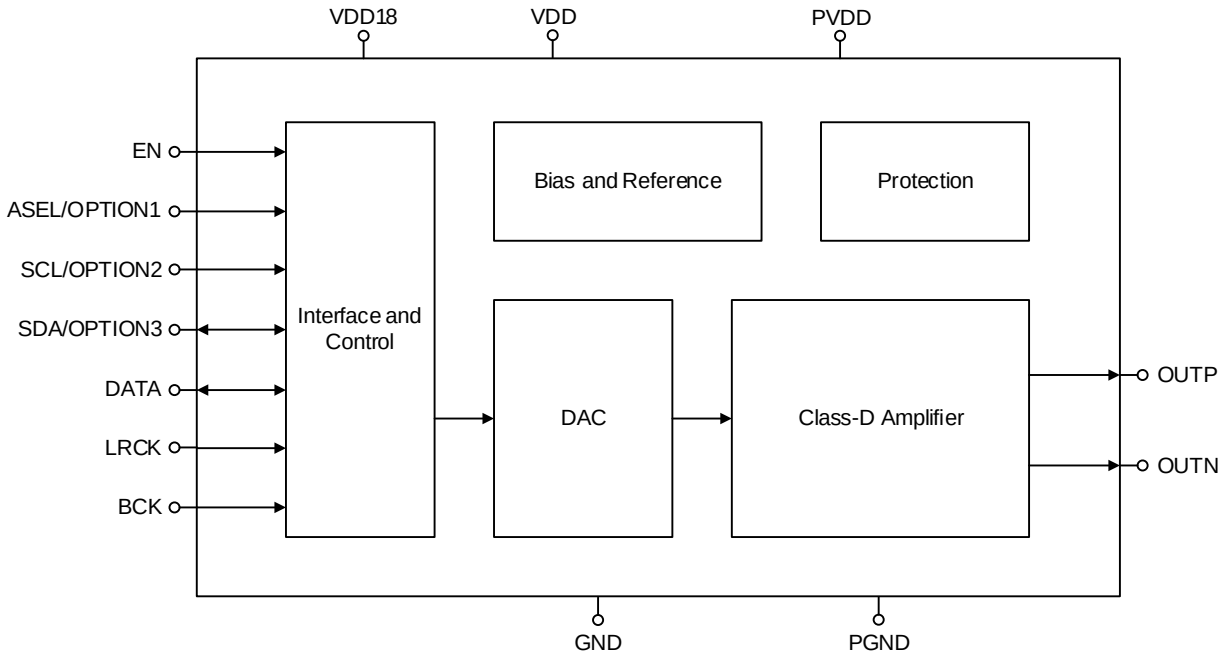
10 Functional Block Diagram



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11 Absolute Maximum Ratings

(Note 3)

- VDD, PVDD ---------- –0.3V to 6V
- OUTP, OUTN ---------- –0.3V to 6V
- VDD18 ---------- –0.3V to 2.5V
- LRCK, BCK, DATA, SCL/OPTION2, SDA/OPTION3, EN ---------- –0.3V to 5V
- ASEL/OPTION1 ---------- –0.3V to 2.5V
- Power Dissipation, P_D @ T_A= 25°C

  WL-CSP-14B 1.81x1.1 (BSC) ---------- 3.89W

  WDFN-12L 3x3 ---------- 3.24W
- Package Thermal Resistance (Note 4)

  WL-CSP-14B 1.81x1.1 (BSC), θ_{JA} ---------- 25.7°C/W

  WDFN-12L 3x3, θ_{JA} ---------- 30.8°C/W

  WDFN-12L 3x3, θ_{JC} ---------- 5.4°C/W
- Junction Temperature ---------- 150°C
- Lead Temperature (Soldering, 10sec.) ---------- 260°C
- Storage Temperature Range ---------- –65°C to 150°C
- ESD Susceptibility (Note 5)

  HBM (Human Body Model) ---------- 2kV

Note 3. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 4. θ_{JA} is simulated under natural convection (still air) at T_A = 25°C with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard. θ_{JC} is simulated at the exposed pad of the package.

Note 5. Devices are ESD sensitive. Handling precautions are recommended.

12 Recommended Operating Conditions

(Note 6)

- Junction Temperature Range ---------- –40°C to 125°C
- Ambient Temperature Range ---------- –40°C to 85°C

Note 6. The device is not guaranteed to function outside its operating conditions.

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13 Electrical Characteristics

(V_{DD} = 5V, V_{DD18} = 1.8V, load = 8Ω + 33μH, T_A = 25°C, unless otherwise specified.)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
System Performance						
Operating Condition	V_{DD}		2.5	5.0	5.5	V
	V_{DD18}		1.71	1.8	1.98	
Quiescent Current	I_{Q_VDD}	BCK/LRCK on, DATA silence (Silence detection = disable)	--	1.78	2.83	mA
	I_{Q_VDD18}	BCK/LRCK on, DATA silence (Silence detection = disable)	--	0.94	1.5	
Silence Mode Current	$I_{SILENCE_VDD}$	BCK/LRCK on, DATA silence (Silence detection = enable)	--	0.05	--	mA
	$I_{SILENCE_VDD18}$	BCK/LRCK on, DATA silence (Silence detection = enable)	--	0.50	--	
SUSP Mode Current	I_{SUSP_VDD}	BCK/LRCK/DATA at 0V	--	1	--	μA
	I_{SUSP_VDD18}	BCK/LRCK/DATA at 0V	--	10	--	
Shutdown Current	I_{SHDN_VDD}	BCK/LRCK/DATA at 0V, EN = 0V	--	1	--	μA
	I_{SHDN_VDD18}	BCK/LRCK/DATA at 0V, EN = 0V	--	1	--	
Output Stage On-Resistance	R_{ON}	PMOS+NMOS	--	340	--	mΩ
Turn-On Time	t_{ON}	From SUSP to full gain output Sample rate = 48kHz	--	--	1	ms
Beep Sound_I²C Control Mode Frequency	$f_{SW_BEEP_I2C}$	ASEL/OPTION1 = 0V, Selection I	175	200	225	Hz
		ASEL/OPTION1 = 0V, Selection II (Default)	350	400	450	
		ASEL/OPTION1 = 0V, Selection III	700	800	900	
		ASEL/OPTION1 = 0V, Selection IV	850	1000	1150	
Beep Sound_HW Control Mode Frequency	$f_{SW_BEEP_HW}$	ASEL/OPTION1 = 0V	350	400	450	Hz
Analog Performance						
Output Power	P_O	THD + N < 10% @ 4Ω + 33μH	--	3.2	--	W
		THD + N < 10% @ 8Ω + 33μH	--	1.8	--	

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Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Full-Scale Output Voltage	V_{OUT}	Gain = 0dB	0.94	1	1.06	V_{rms}
		Gain = 12dB (default) VDD/VDDP = 5.5V	3.6	--	3.85	
Output Gain	Gain	Analog (Class-D)	0	--	13.5	dB
		Step	--	1.5	--	
		Error	–0.5		0.5	
		Digital (Volume)	–103	--	24	
		Step	--	0.0625	--	
Signal to Noise Ratio	SNR	A-Weighting, THD + N Po = 1% Input: silence	--	120	--	dB
Dynamic Range	DR	A-Weighting @ THD + N Po = 1% Input: –60dBFs @ 8Ω + 33μH	--	112	--	dB
Total Harmonic Distortion + Noise	$THD+N_{1kHz}$	POUT = 1W @ 4Ω + 33μH	--	0.02	--	%
		POUT = 0.5W @ 8Ω + 33μH	--	0.02	--	
		POUT = 50mW @ 8Ω + 33μH	--	0.012	--	
Power Supply Rejection Ratio	$PSRR_{VDD}$	217Hz, VDD ripple = 200mVpp	--	85	--	dB
		10kHz, VDD ripple = 200mVpp	--	82	--	
	$PSRR_{VDD18}$	217Hz, VDD18 ripple = 15mVpp	--	87	--	
Output Noise	V_N	A-weighted, 24/32-bit DATA	--	8	--	μV_{rms}
Output Offset Voltage	V_{OFFSET}	DC offset (For WL-CSP package)	–2.5	±0.4	2.5	mV
		DC offset (For WDFN package)	–1	±0.4	1	
Class-D Switch Frequency	f_{SW}		--	--	450	kHz
Frequency Response	FR	20Hz to 20kHz	–0.5	--	0.5	dB
Efficiency	η	THD + N = 10% @ 8Ω + 33μH	--	92.5	--	%
Protect Performance						
Undervoltage Protection	V_{UVP_VDD}	VDD falling	2.1	2.2	2.3	V
	$V_{UVP_HYS_VDD}$	Hysteresis rising	--	0.15	--	V
	V_{UVP_VDD18}	VDD18 falling	1.3	1.4	1.5	V
	$V_{UVP_HYS_VDD18}$	Hysteresis rising	--	0.15	--	V
Over-Temperature Protection	T_{OTP}	Temperature rising	--	150	--	°C
		Hysteresis falling	--	25	--	°C

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Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Overcurrent Protection	I_{OCP}	VDD = 5V	--	2.8	--	A
	t_{OCP}	Auto-recovery time	--	100	--	ms
I²C Interface Electrical Characteristics						
High-Level Input Voltage	V_{IH_I2C}		1.26	--	--	V
Low-Level Input Voltage	V_{IL_I2C}		--	--	0.54	V
Pull-Down Current	I_{PD}		--	2	--	uA
Digital Output Low (SDA)	V_{OL}	$I_{PULL-UP}$ = 3mA	--	--	0.4	V
Clock Operating Frequency	f_{SCL}		--	--	400	kHz
Bus Free Time Between Stop and Start Condition	t_{BUF}		1.3	--	--	µs
Hold Time After (Repeated) Start Condition	$t_{HD;STA}$		0.6	--	--	µs
Repeated Start Condition Setup Time	$t_{SU;STA}$		0.6	--	--	µs
Stop Condition Time	$t_{SU;STD}$		0.6	--	--	µs
Data Hold Time	$t_{HD;DAT(OUT)}$		225	--	--	ns
Input Data Hold Time	$t_{HD;DAT(IN)}$		0	--	900	ns
Data Setup Time	$t_{SU;DAT}$		100	--	--	ns
Clock Low Period	t_{LOW}		1.3	--	--	µs
Clock High Period	t_{HIGH}		0.6	--	--	µs
Clock Data Fall Time	t_{F_I2C}		20	--	300	ns
Clock Data Rise Time	t_{R_I2C}		20	--	300	ns
Spike Suppression Time	t_{SP}		--	--	50	ns
I²S / TDM Interface						
High-Level Input Voltage	V_{IH_I2S}		1.26	--	--	V
Low-Level Input Voltage	V_{IL_I2S}		--	--	0.54	V
Setup Time FS to BCK Rising Edge	t_{SU1}		10	--	--	ns
Hold Time FS from BCK Rising Edge	t_{H1}		10	--	--	ns
Setup Time DATAI to BCK Rising Edge	t_{SU2}		10	--	--	ns
Hold Time DATAI from BCK Rising Edge	t_{H2}		10	--	--	ns
Rise Time for BCK/LRCLK	t_{R_I2S}	10% - 90 % rise time	--	--	8	ns
Fall Time for BCK/LRCLK	t_{F_I2S}	90% - 10 % fall time	--	--	8	ns
Sample Rate	f_S	Sample rate	8	--	96	kHz
Bit Clock	BCK	Bit clock	0.256	--	24.576	MHz
Delay Time	DIN to BCLK Setup Time	Delay time	10	--	--	ns
Jitter Tolerance	BCK/LRCK	Jitter tolerance	--	12	--	ns

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Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
TDM Device Channel			--	8	--	CH

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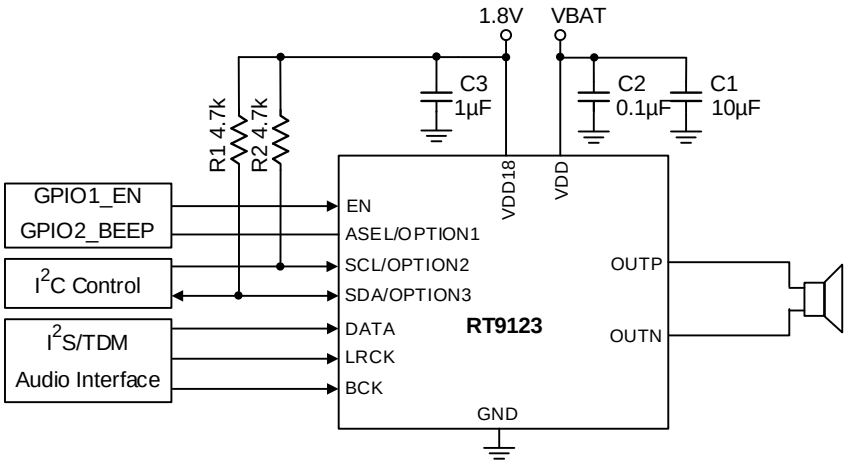
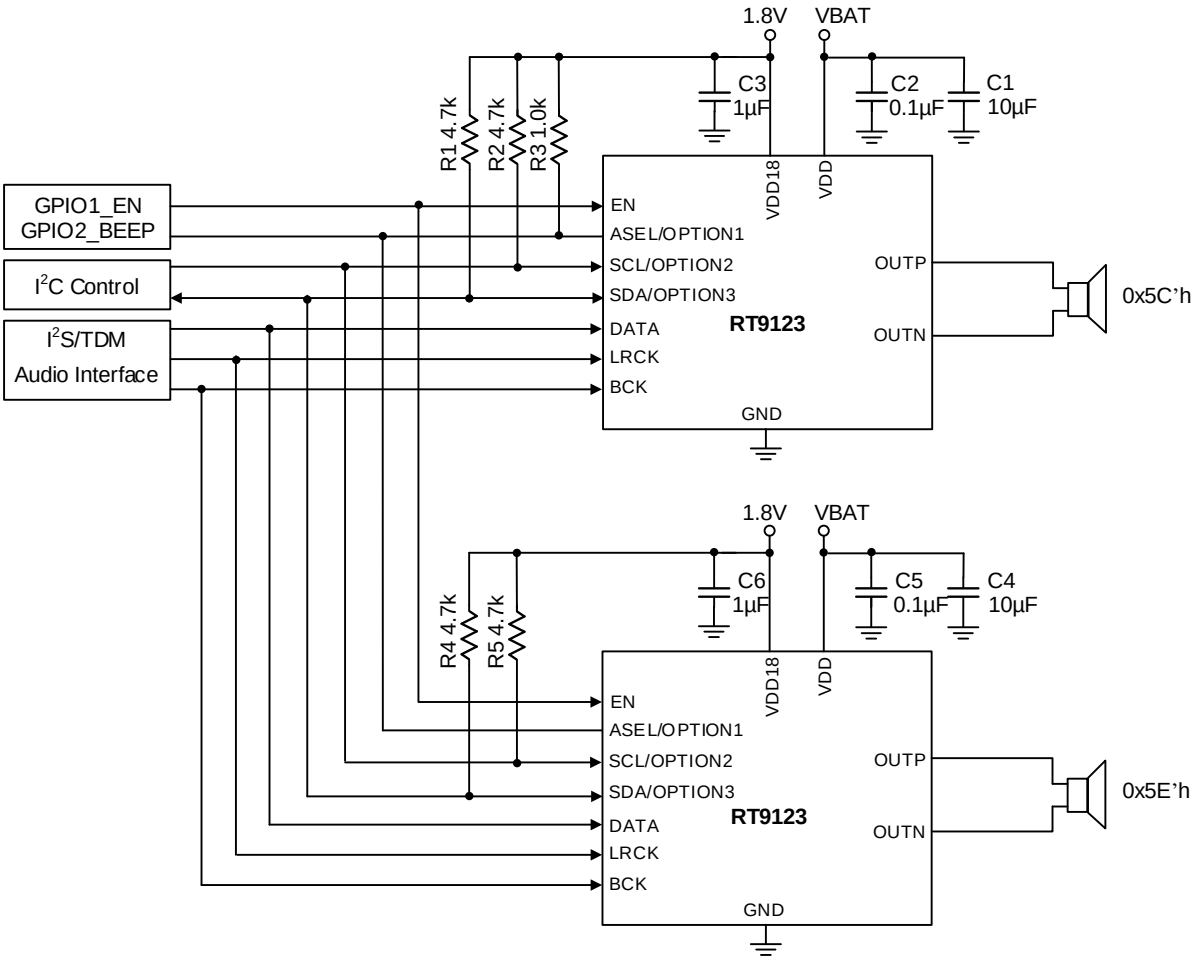
14 Typical Application Circuit

14.1 Mono Speaker with I²C Control Mode with Address 0x5E'h



14.2 Stereo Speaker with I²C Control Mode with Address 0x5C'h and 0x5E'h



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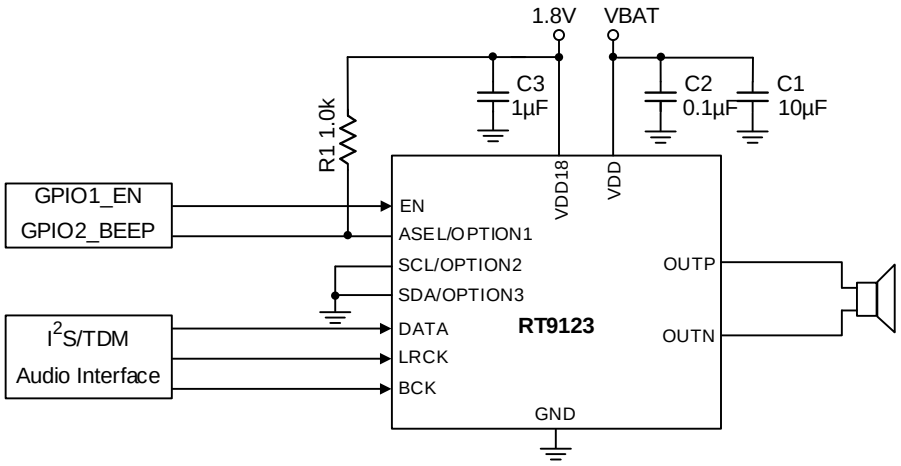
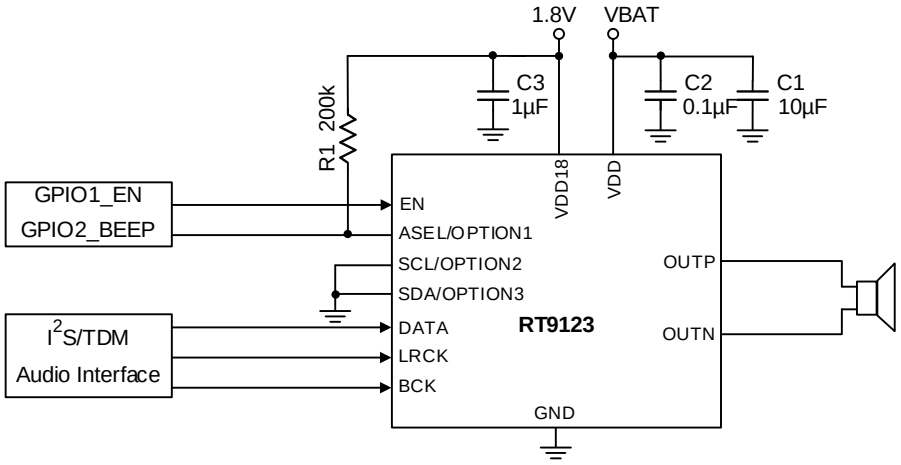
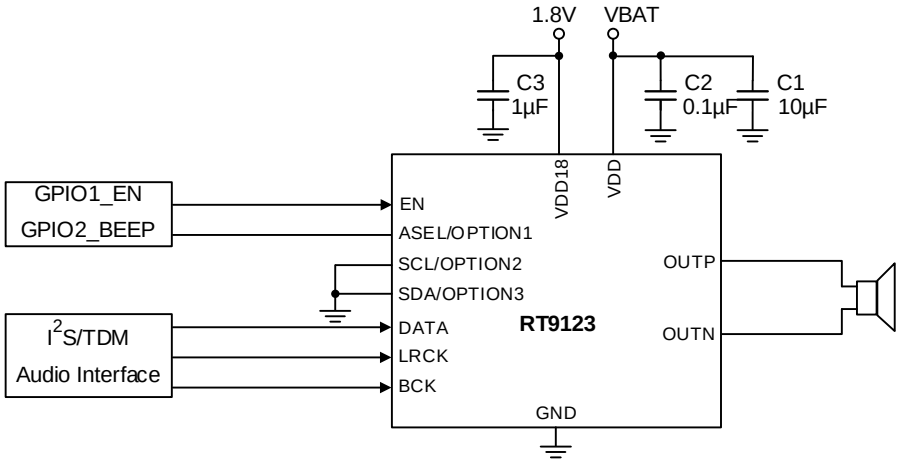
14.3 Mono Speaker with HW Control Mode (Gain = 12.0dB)



14.4 Mono Speaker with HW Control Mode (Gain = 10.5dB)



14.5 Mono Speaker with HW Control Mode (Gain = 9.0dB)



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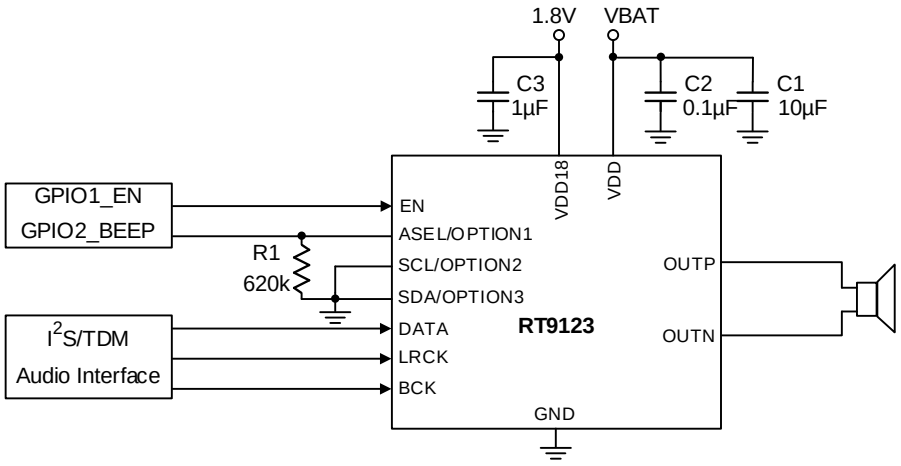
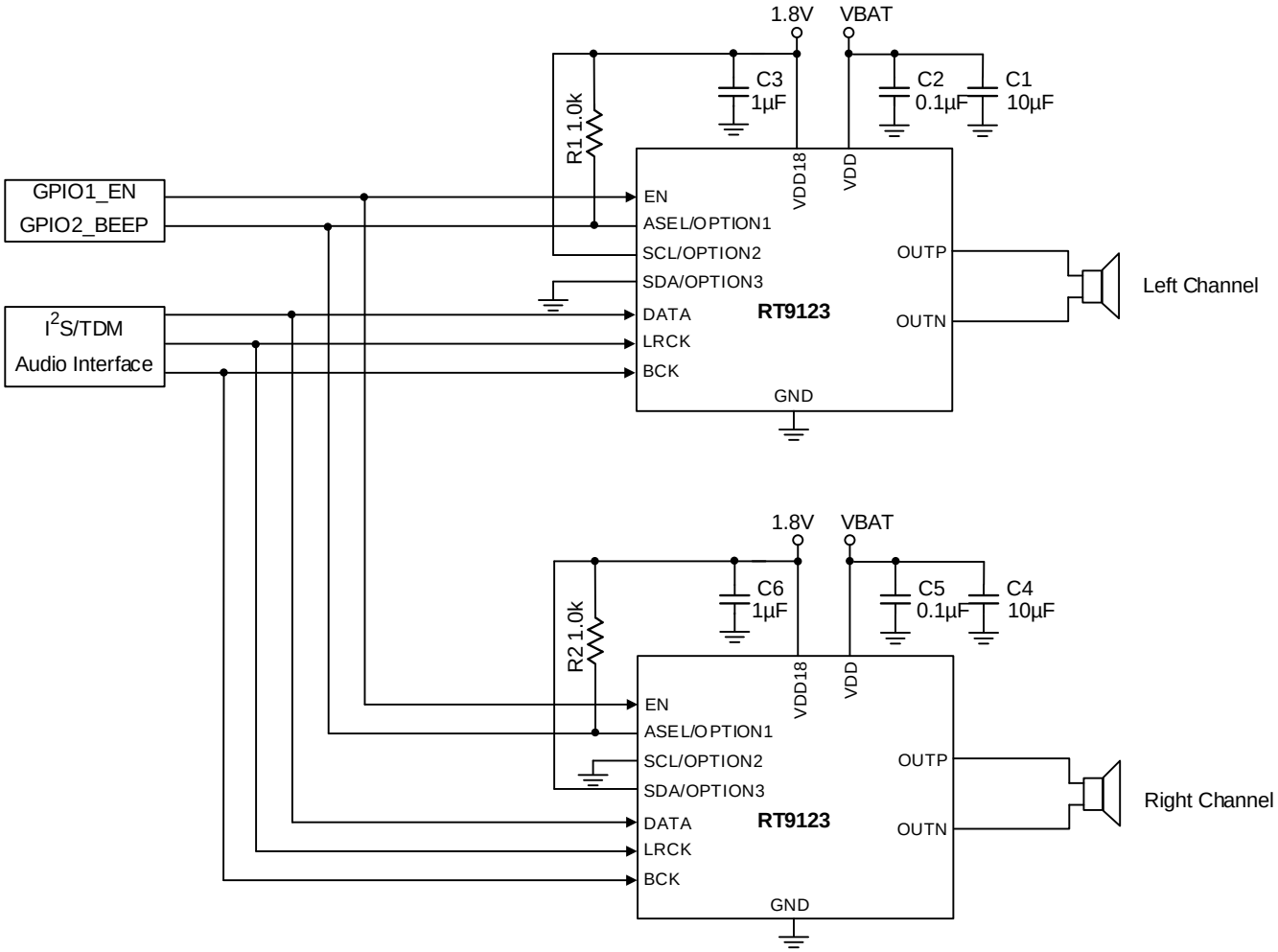
14.6 Mono Speaker with HW Control Mode (Gain = 7.5dB)



14.7 Stereo Speaker with HW Control Mode (Gain = 12.0dB)



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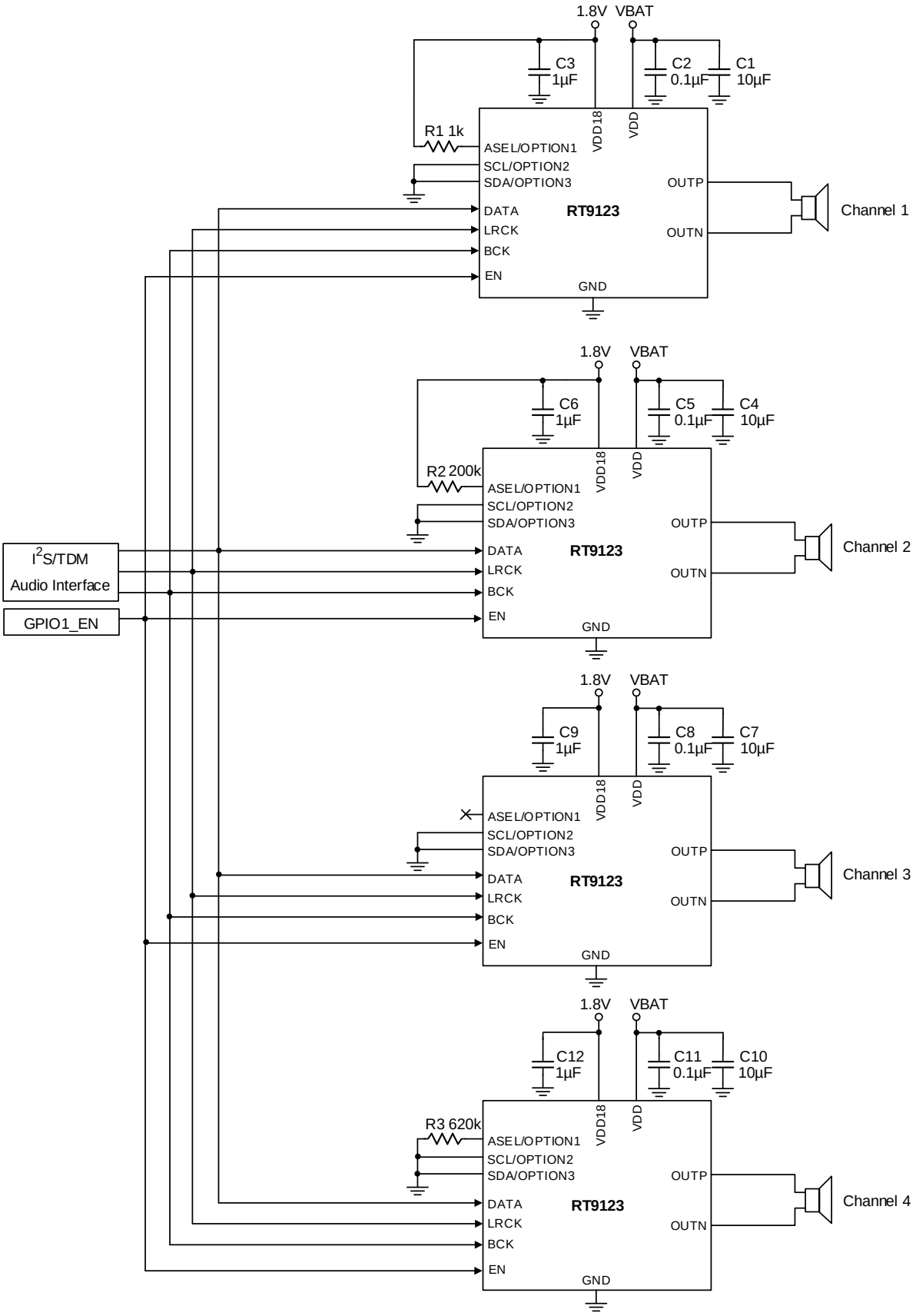
14.8 4-Channel TDM with HW Control Mode (Gain = 12.0dB)



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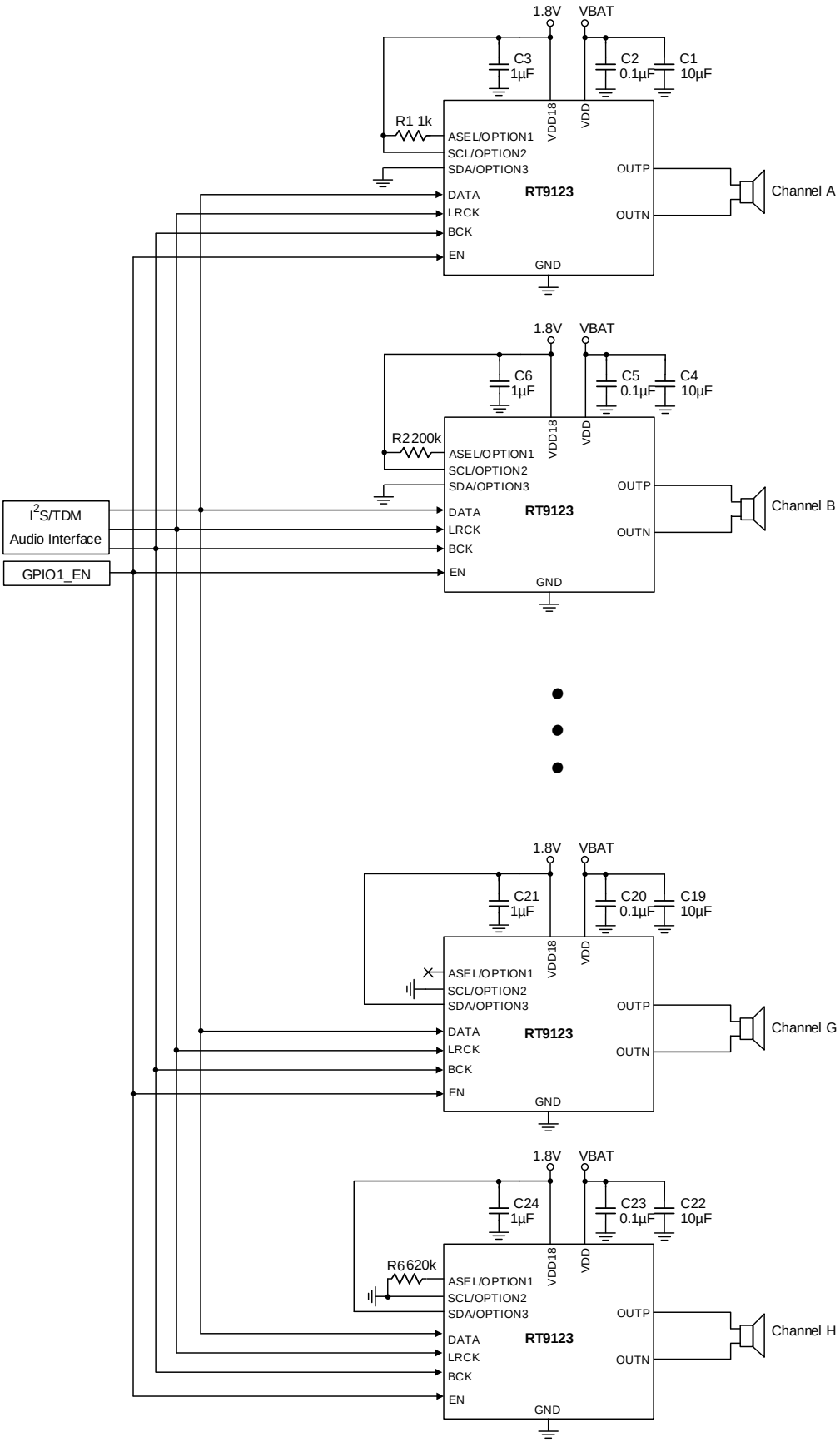
14.9 8-Channel TDM with HW Control Mode (Gain = 12.0dB)



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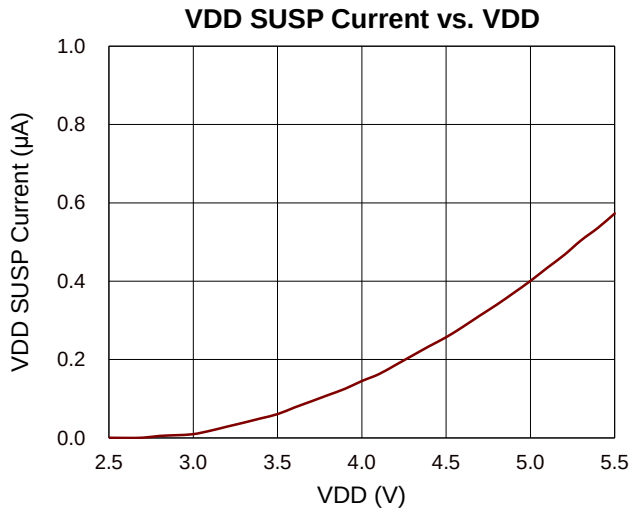
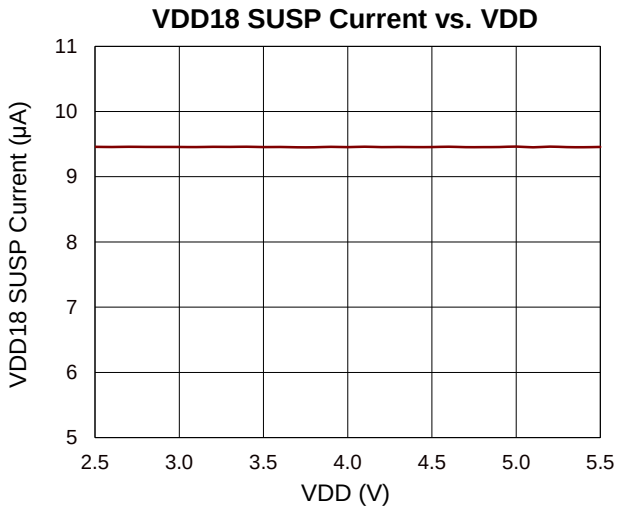
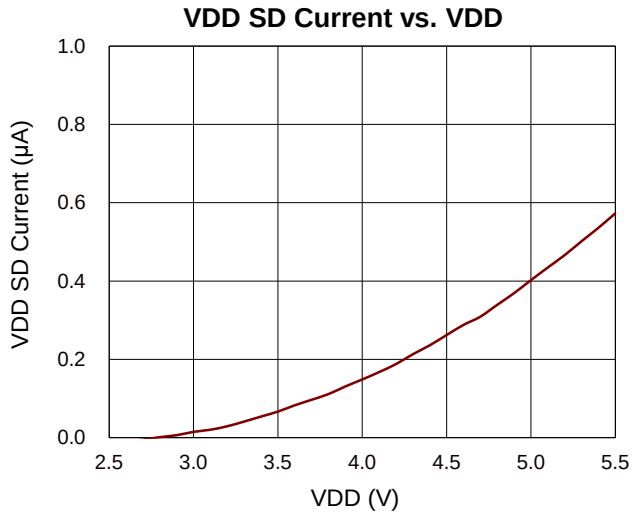
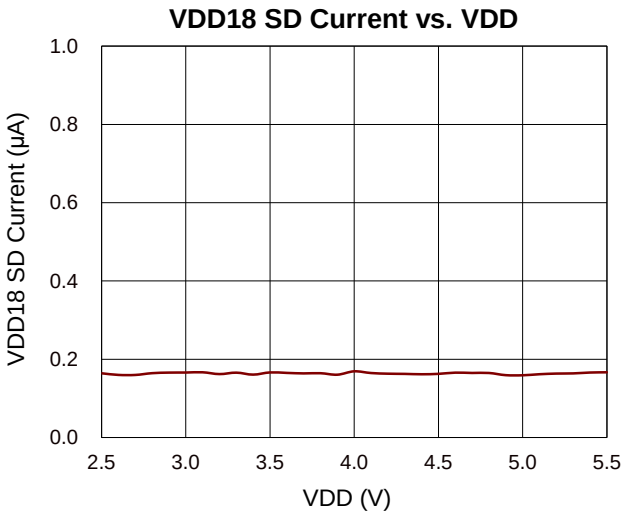
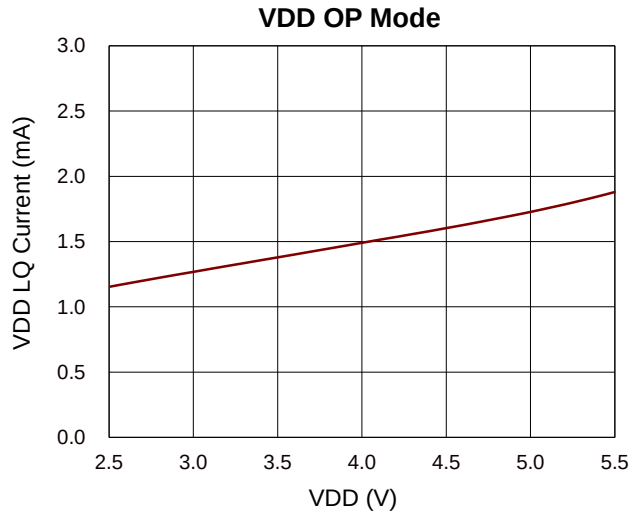
15 Typical Operating Characteristics

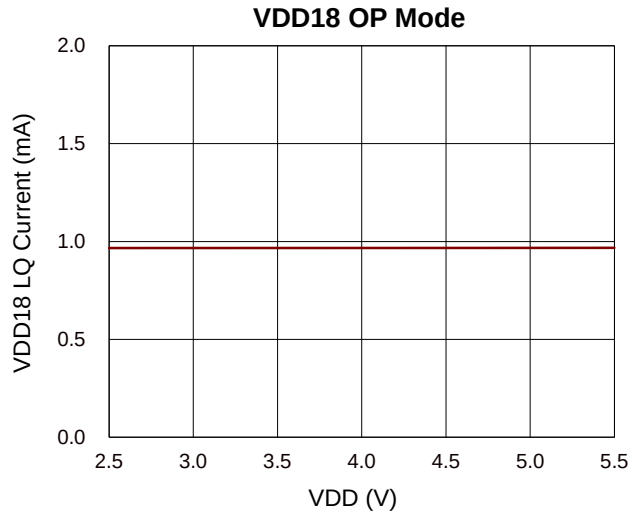












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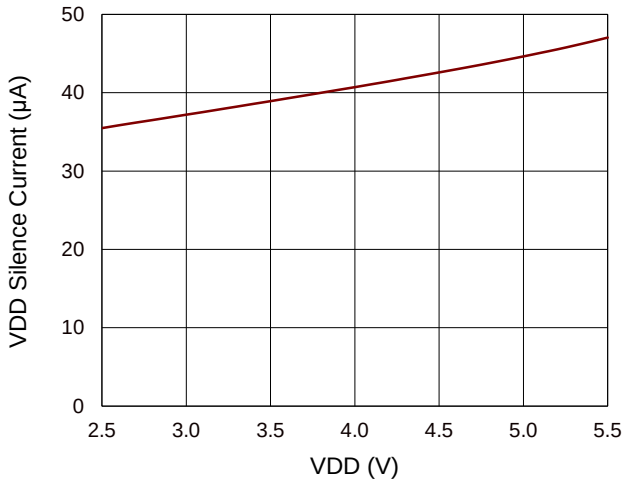
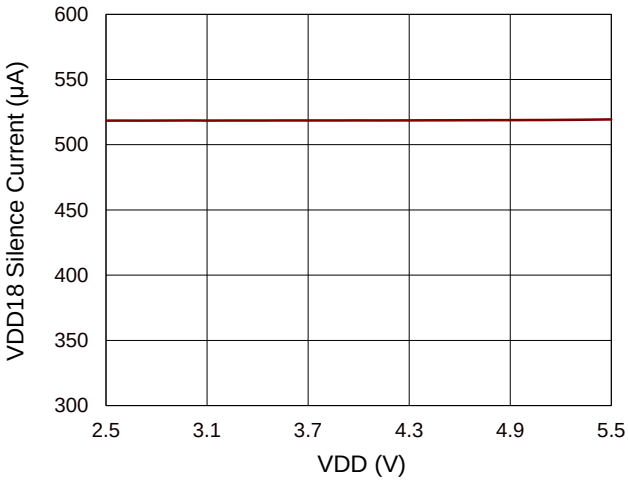
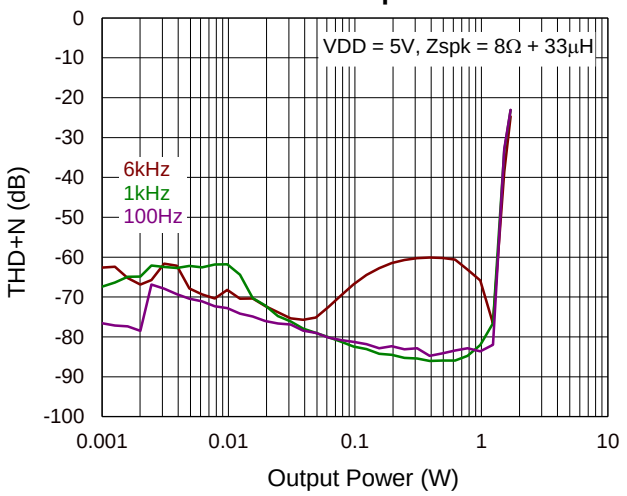
VDD Silence Current vs. VDD



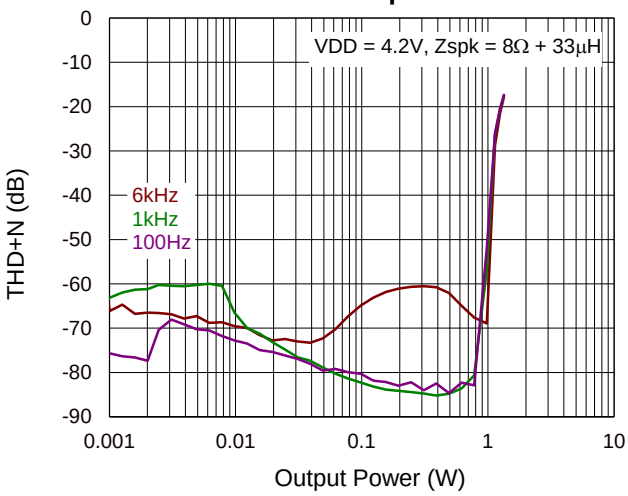
VDD18 Silence Current vs. VDD



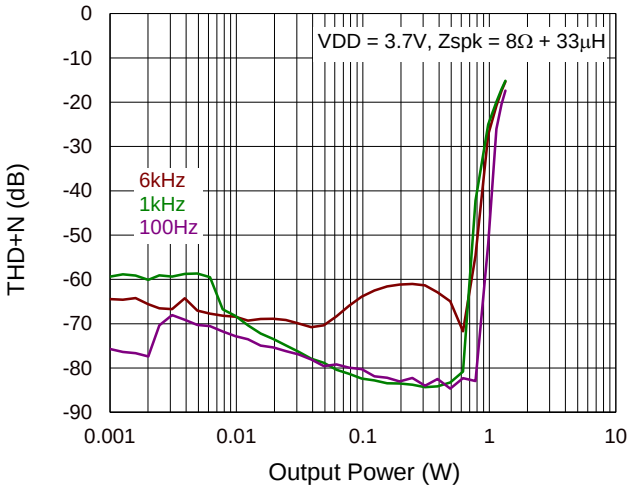
THD+N vs. Output Power



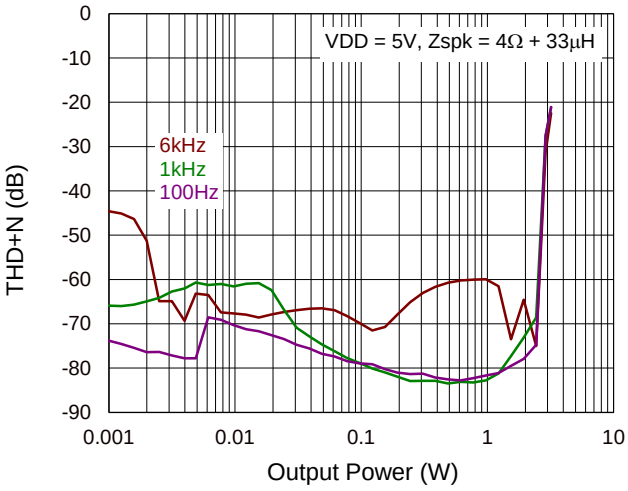
THD+N vs. Output Power



THD+N vs. Output Power



THD+N vs. Output Power



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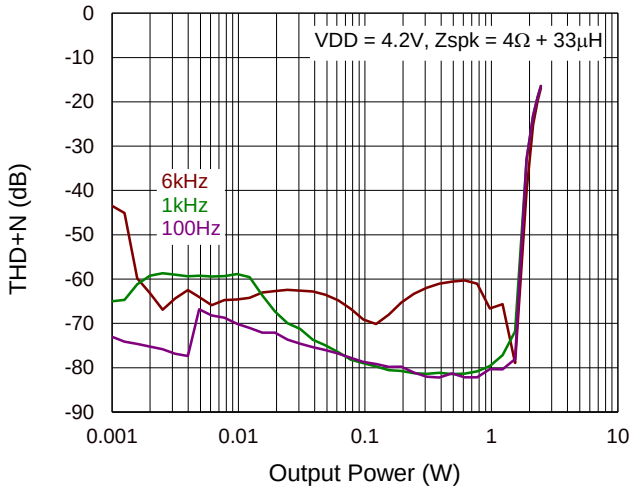
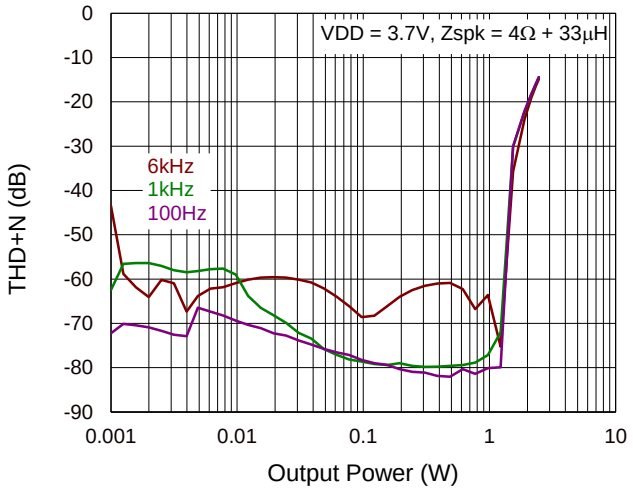
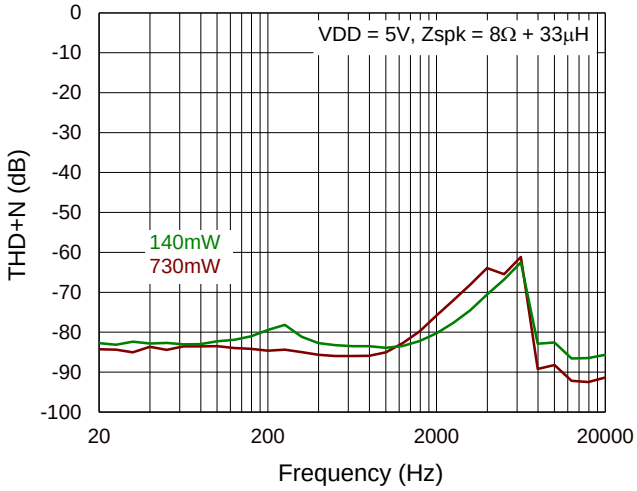
THD+N vs. Output Power



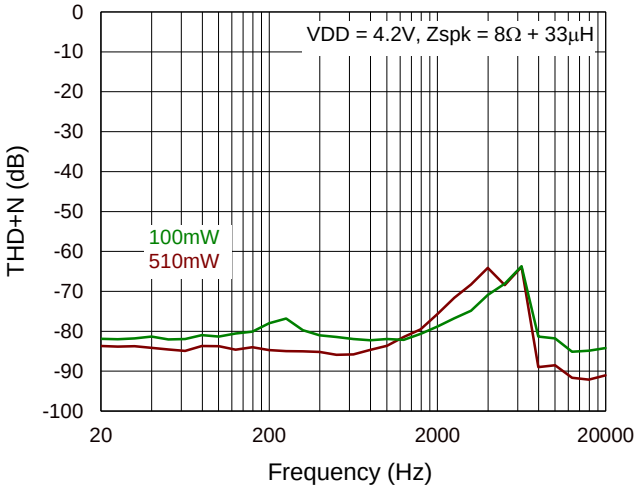
THD+N vs. Output Power



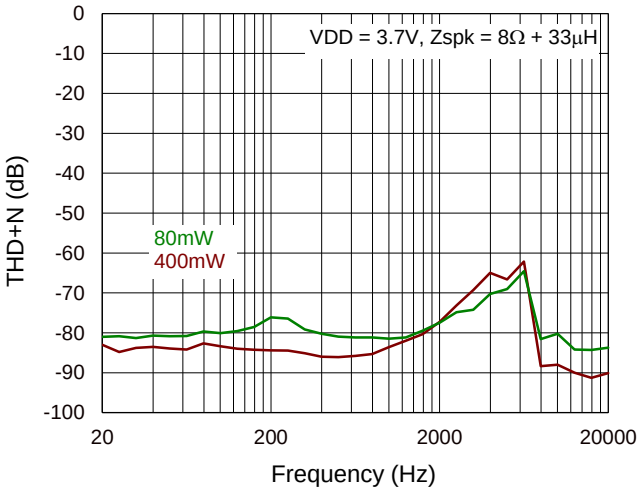
THD+N vs. Frequency



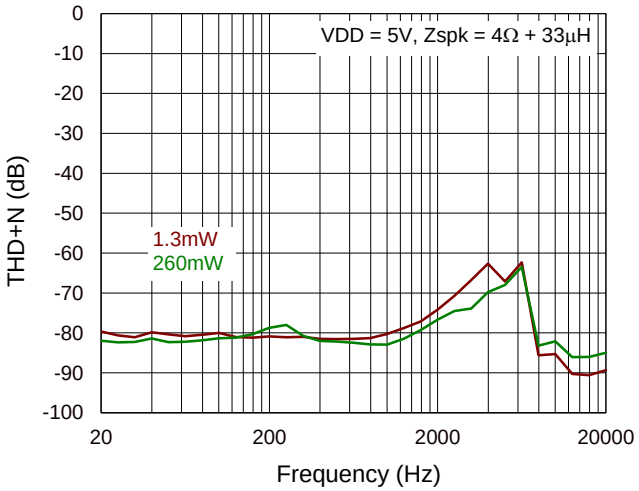
THD+N vs. Frequency



THD+N vs. Frequency



THD+N vs. Frequency



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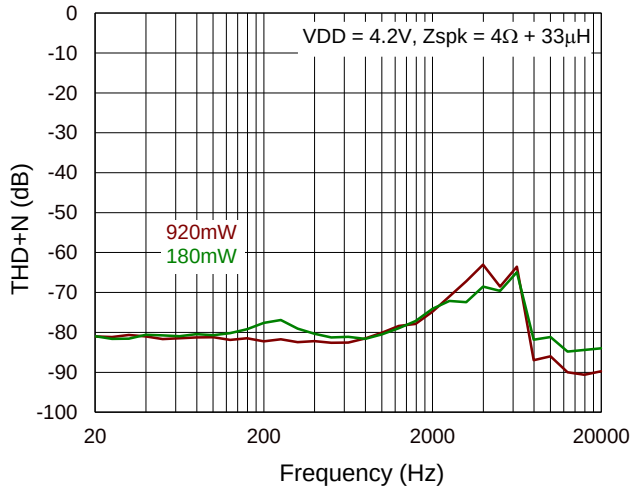
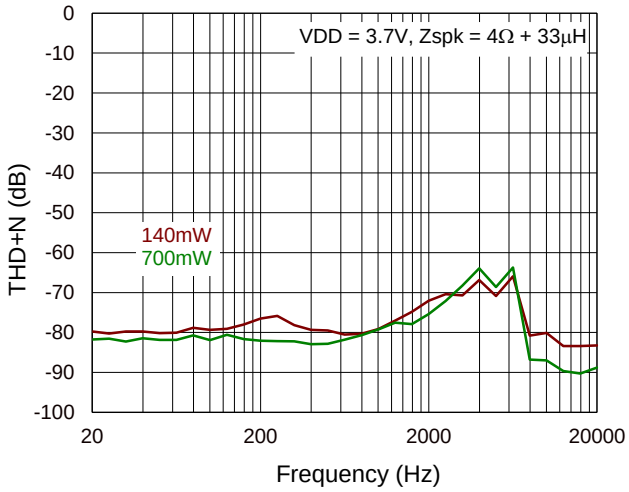
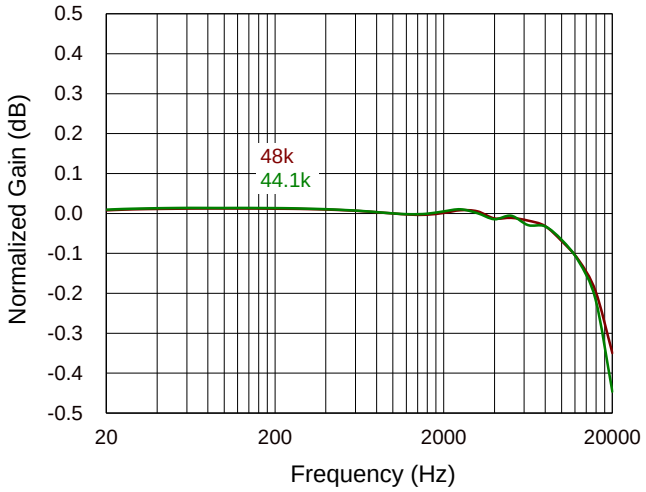
THD+N vs. Frequency



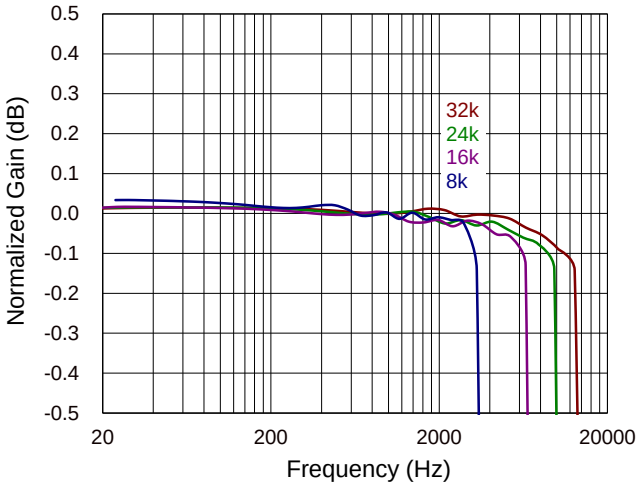
THD+N vs. Frequency



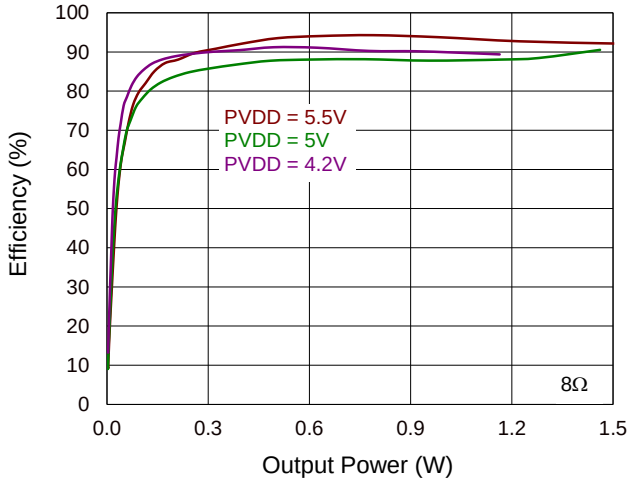
Normalized Gain vs. Frequency



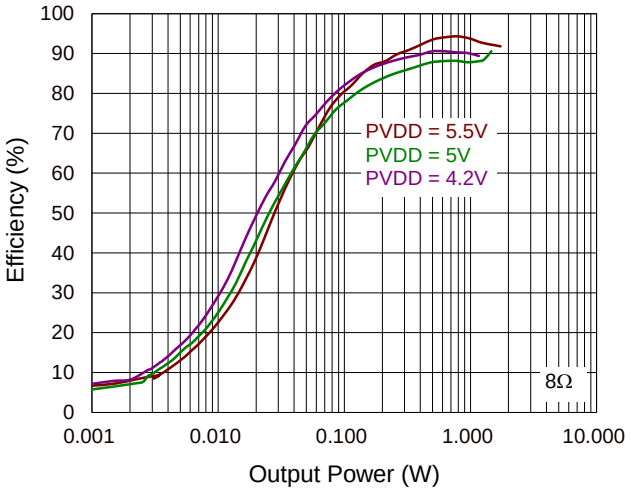
Normalized Gain vs. Frequency



Efficiency vs. Output Power



Efficiency vs. Output Power



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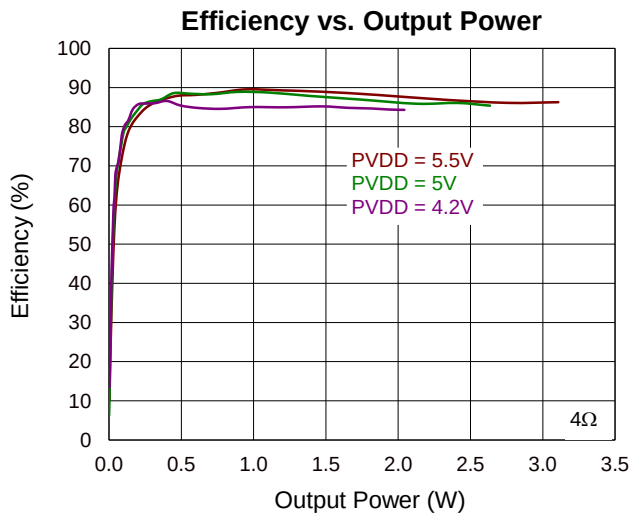

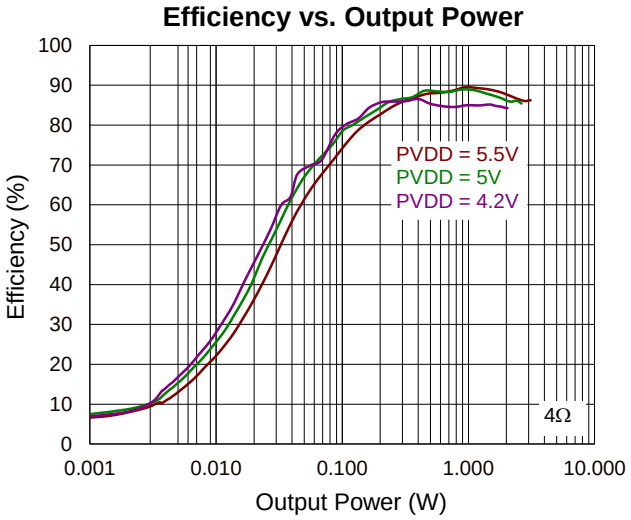

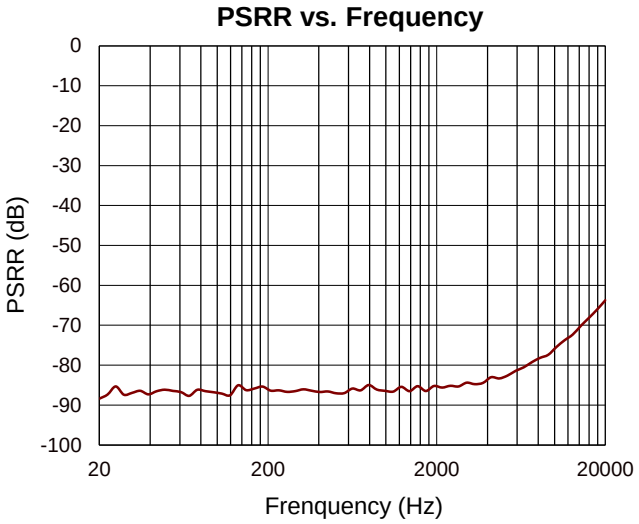

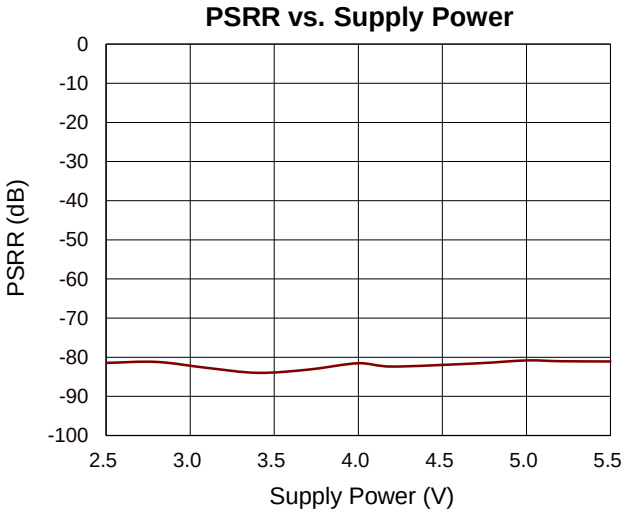

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16 Application Information

(Note 7)

16.1 Operation Modes

The RT9123 operates in several modes, including operating, silence, suspend, power-down, and fault. The operational status of the internal circuit blocks in these different modes is depicted below.

Circuit Block \ Mode		OP	SILENCE	SUSP	FAULT	PWDN
I^2C	SCL/SDA	○	○	○	○	×
I^2S	BCK/SR	○	○	×	○	×
	DATA	○	×	×	○	×
PLL	OSC_1MHz PLL	PLL	OSC_1MHz	×	PLL	×
AMP	Tri-Wav DAC/ADC	○	×	×	×	×
EN	EN	○	○	○	○	×

○ : Normal operation

× : Power down

Table 1. Operation Mode

Mode	Condition	Description
Operating	SYS_STATUS [12] = 1 BCK/SR valid DATA valid EN = 1	1. The EN pin is asserted at a high level. 2. Enable the AMP by setting SYS_STATUS register [12] to 1. 3. The DATA and BCK/SR paths of the I^2S interface are valid. 4. The I^2C bus remains awake. 5. The PLL synchronizes to BCK. 6. The chip will enter operating mode.
Silence	SYS_STATUS [12] = 1 BCK/SR valid DATA invalid EN = 1	1. The EN pin is asserted at a high level. 2. Enable the AMP by setting SYS_STATUS register [12] to 1. 3. The BCK/SR path of the I^2S interface is valid. 4. The DATA path of the I^2S is below the threshold. 5. The I^2C bus remains awake. 6. The OSC_1MHz is used to monitor the I^2S bus. 7. The chip will enter silence mode.
Suspend	SYS_STATUS [12] = 1 BCK/SR invalid DATA invalid EN = 1	1. The EN pin is asserted at a high level. 2. Enable the AMP by setting SYS_STATUS register [12] to 1. 3. Most of the clock paths of the I^2S interface are turned off. 4. The I^2C bus remains awake. 5. Monitor the BCK/SR on the I^2S bus to check if the format is correct. 6. The chip will enter suspend mode.

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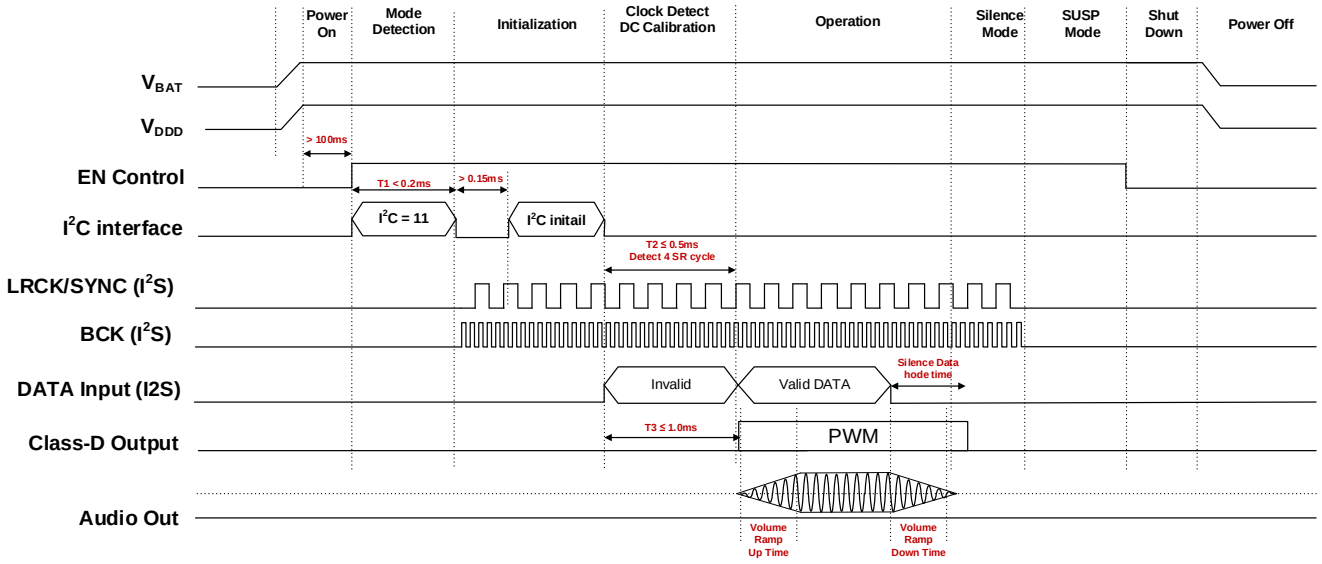
Mode	Condition	Description
Power-down	EN = 0	1. The EN pin is asserted at a low level. 2. The I^2C bus is turned off. 3. The I^2S path is disabled. 4. Power consumption is minimized. 5. The chip will enter power-down mode.
Fault	OTP = 1 OCP = 1 UVP18 = 1 UVP50 = 1 EN = 1	1. The chip enters fault mode when an error event from physical protection mechanisms occurs (OCP, UVP18, UVP50, OTP) 2. The AMP will be turned off. 3. The system exits fault mode after the overcurrent protection event is released for a checking cycle of about 100ms. 4. The system exits fault mode immediately after VDD18, UVP50, or OTP are released.

16.2 Power-On/Off Sequence

16.2.1 I^2C Control Mode



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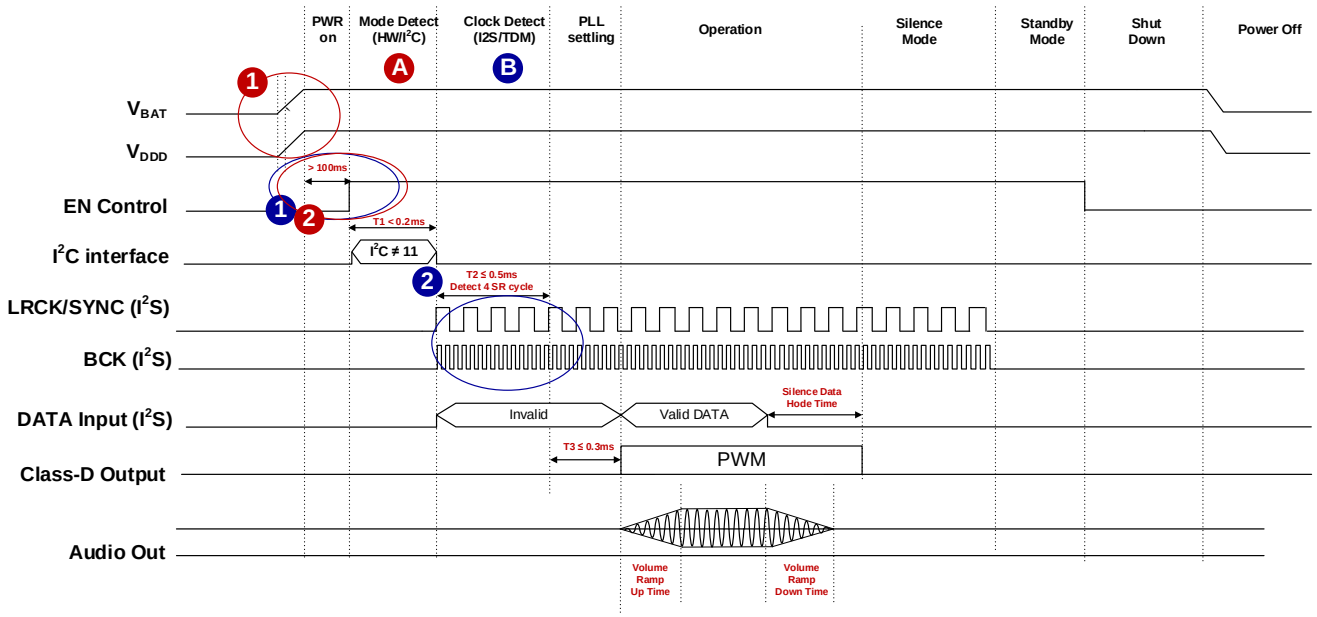
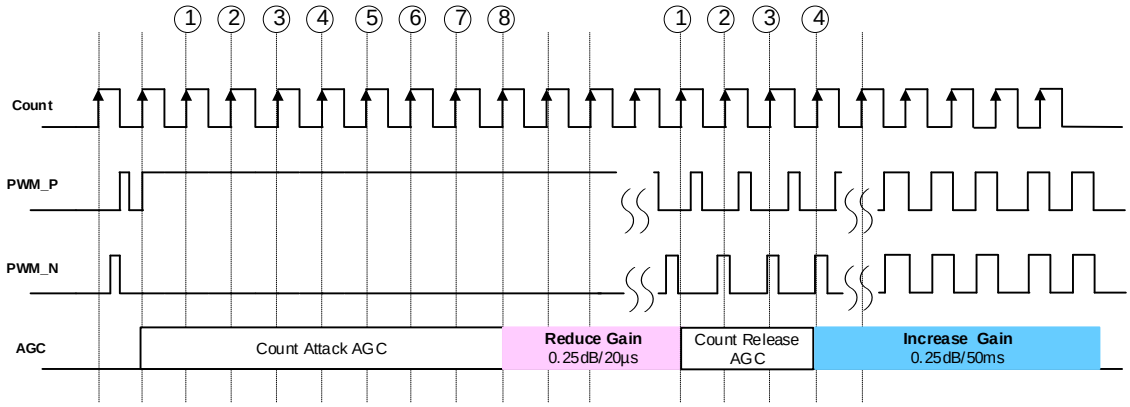
16.2.2 HW Control Mode



A. Mode Detect (HW/I^{2}C) : 1st. VBAT & VDDD toggle (Low to High) 2st. "EN" toggle (Low to High)
B. Clock Detect (I2S/TDM) : 1st. EN" toggle (Low to High) 2nd. "BCK" Switch

16.3 Automatic Gain Control

The RT9123 supports an automatic gain control (AGC) function by the register (CLIP_AGC_EN). This function can detect PWM cycles to determine if the output signal is clipping at peak levels. When output clipping is detected, the AGC circuit will start to ramp down the output signal by reducing the gain. If the AGC detects that the output signal is not clipped, it will release the gain to the default value.



The count attack AGC and count release AGC can be adjusted using the CLIP_DET_SEL register in I^{2}C mode. Additionally, the AGC_ATTACK_RATE and AGC_RELEASE_RATE registers can be adjusted to set the attack and release times for reducing and increasing gain, respectively.

16.4 PIN Configuration for Detection

16.4.1 SCL/OPTION2 and SDA/OPTION3 PIN Configuration for Mode Selection

The RT9123 supports two operating modes that depend on the SCL/OPTION2 and SDA/OPTION3 pins for mode determination.

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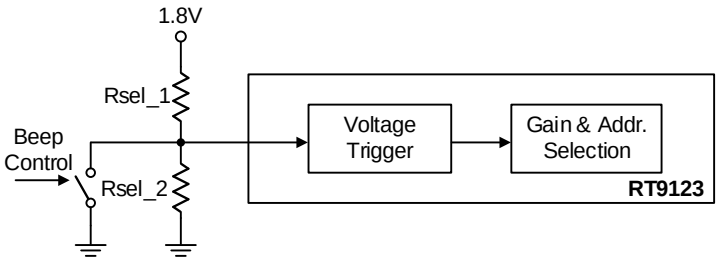
When SCL/OPTION2 = 1 and SDA/OPTION3 = 1, the mode is defined as "I^{2}C Control Mode". This mode requires the host to initiate and control the on/off sequence of the amplifier via I^{2}C commands.



Mode	SCL/OPTION2	SDA/OPTION3	I^{2}S_BCK	ASEL	Device	Gain
I^{2}C Mode	1	1	N/A	R_{sel_1} (1k)	0x5C'h	12dB
				R_{sel_1} (200k)	0x5D'h	
				NC	0x5E'h	
				R_{sel_2} (620k)	0x5F'h	
				GND	BEEP	Beep sound

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Except for the condition where SDA/OPTION2 = 1 and SCL/OPTION3 = 1, all other modes are defined as “HW Control Mode”. This mode operates automatically and does not require initialization by an I²C command.

Mode	SCL/OPTION3	SDA/OPTION2	I²S_BCK	ASEL	Channel Selection	Gain
HW Control Mode (I²S)	0	0	64fs 48fs 32fs	R_{SEL_1} (1k)	(L+R)/2	12.0dB
				R_{SEL_1} (200k)		10.5dB
				NC		9.0dB
				R_{SEL_2} (620k)		7.5dB
				GND	BEEP	Beep sound
HW Control Mode (I²S)	0	1	64fs 48fs 32fs	R_{SEL_1} (1k)	R	12.0dB
				R_{SEL_1} (200k)		10.5dB
				NC		9.0dB
				R_{SEL_2} (620k)		7.5dB
				GND	BEEP	Beep sound
HW Control Mode (I²S)	1	0	64fs 48fs 32fs	R_{SEL_1} (1k)	L	12.0dB
				R_{SEL_1} (200k)		10.5dB
				NC		9.0dB
				R_{SEL_2} (620k)		7.5dB
				GND	BEEP	Beep sound
HW Control Mode (TDM)	0	0	128fs (32bit) 256fs (32bit) Fixed: 4-CH	R_{SEL_1} (1k)	Channel 1	12dB
				R_{SEL_1} (200k)	Channel 2	
				NC	Channel 3	
				R_{SEL_2} (620k)	Channel 4	
				GND	BEEP	Beep sound
HW Control Mode (TDM)	1	0	128fs (16bit) 256fs (32bit) Fixed: 8-CH	R_{SEL_1} (1k)	Channel A	12dB
				R_{SEL_1} (200k)	Channel B	
				NC	Channel C	
				R_{SEL_2} (620k)	Channel D	
				GND	BEEP	Beep sound
HW Control Mode (TDM)	0	1	128fs (16bit) 256fs (32bit) Fixed: 8-CH	R_{SEL_1} (1k)	Channel E	12dB
				R_{SEL_1} (200k)	Channel F	
				NC	Channel G	
				R_{SEL_2} (620k)	Channel H	
				GND	BEEP	Beep sound

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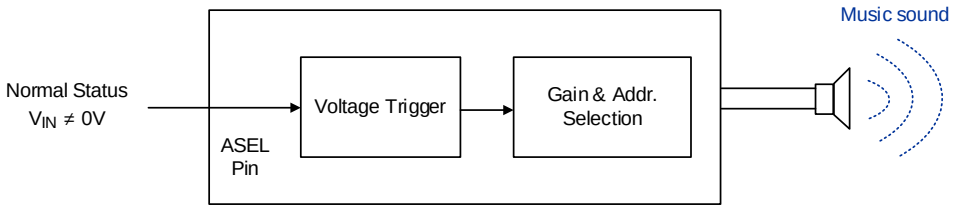
16.4.2 ASEL/OPTION1 Pin Configuration for Address/Device or Gain Selection

The ASEL/OPTION1 pin serves a multifunctional purpose in each mode.

Upon toggling the EN pin, the ASEL/OPTION1 pin can automatically detect the voltage threshold and enter different states. The voltage threshold can be set by connecting the pin to VDD18 using a 1kΩ (5%) resistor, connecting the pin to VDD18 using a 200kΩ (5%) resistor, connecting the pin to GND using a 620kΩ (5%) resistor, or leaving the pin unconnected.



In I^2C control mode, there are four address selections: 0x5C, 0x5D, 0x5E, and 0x5F.

Mode	ASEL/OPTION1	Address
I^2C Control Mode	R_{SEL_1} (1k)	0x5C'h
	R_{SEL_1} (200k)	0x5D'h
	NC	0x5E'h
	R_{SEL_2} (620k)	0x5F'h

In the I^2S format of HW control mode, there are four gain selections: 12.0dB, 10.5dB, 9.0dB, and 7.5dB.

Mode	ASEL/OPTION1	Gain
HW Control Mode (I^2S format)	R_{SEL_1} (1k)	12.0dB
	R_{SEL_1} (200k)	10.5dB
	NC	9.0dB
	R_{SEL_2} (620k)	7.5dB

In the TDM format of HW control mode, there are 4 channels available for device selection.

Mode	ASEL/OPTION1	Device
HW Control Mode (TDM format)	R_{SEL_1} (1k)	Channel 1
	R_{SEL_1} (200k)	Channel 2
	NC	Channel 3
	R_{SEL_2} (620k)	Channel 4

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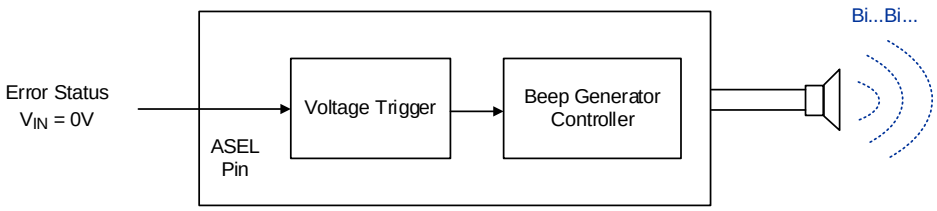
16.4.3 ASEL/OPTION1 Pin Configuration for Beep Sound

Whenever VDD/VDD18 power is on and the EN pin is asserted high, pulling the ASEL pin to 0V will trigger a beep sound.



16.4.4 EN Pin Configuration for Shutdown Mode

The audio chip enters shutdown mode if the EN pin is asserted to a low level. All internal blocks are turned off in shutdown mode, and the device consumes the minimum quiescent current from the VDD and VDD18 power supplies.

16.5 Audio Bits and Frame Widths

16.5.1 I^2C Control Mode

16.5.1.1 Data Format

The I^2S formats supported by the RT9123 are listed below:

Interface	BCK Frequency	Data Format
I^2S Standard	32fs	up to 16-bit
I^2S Standard	48fs	up to 24-bit
I^2S Standard	64fs	up to 32-bit
Left-Justified	32fs	up to 16-bit
Left-Justified	48fs	up to 24-bit
Left-Justified	64fs	up to 32-bit
Right-Justified (16-bit)	32fs/48fs/64fs	16-bit
Right-Justified (20-bit)	48fs/64fs	20-bit
Right-Justified (24-bit)	48fs/64fs	24-bit
Right-Justified (32-bit)	64fs	32-bit
TDM 8-slot	64fs	64-bit
TDM 16-slot	128fs	128-bit
TDM 32-slot	256fs	256-bit

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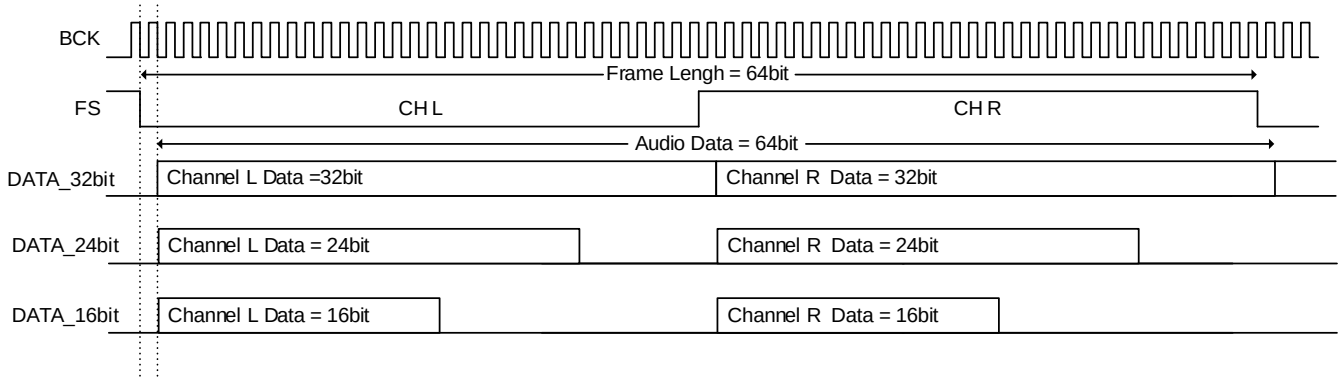

Figure 1. I²S Format with I²C Control Mode

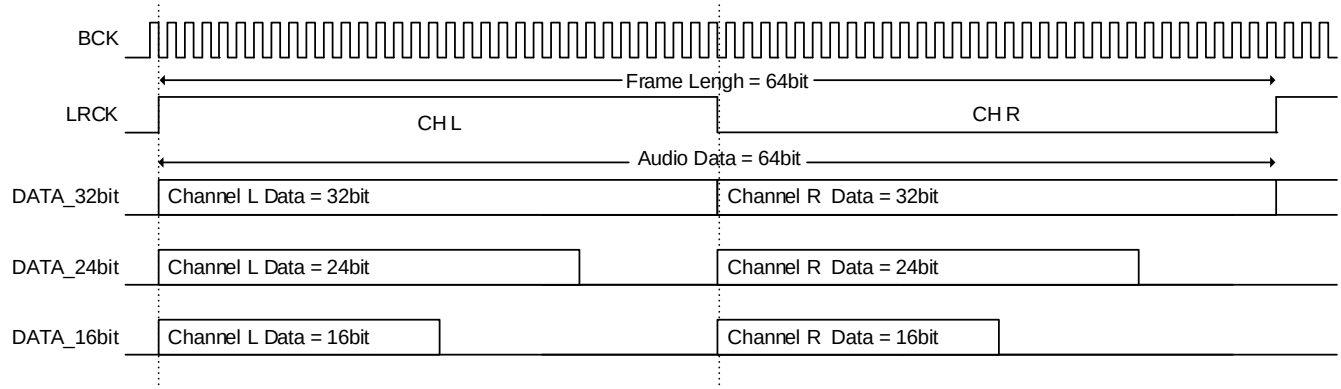

Figure 2. Left-Justified Format with I²C Control Mode

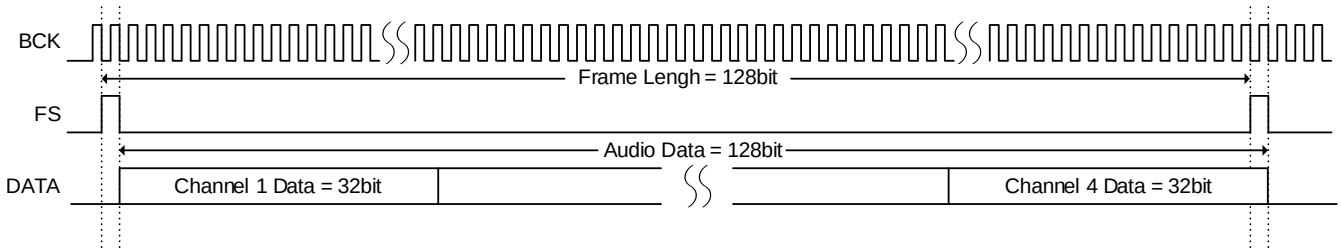

Figure 3. TDM Standard Format (1bit offset) with I²C Control Mode

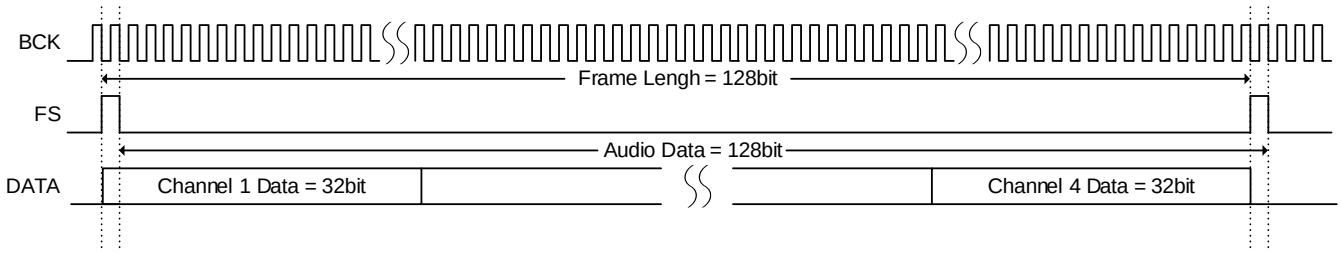

Figure 4. TDM Left-Justified Format with I²C Control Mode

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16.5.2 I^2S Sampling Rate

I^2S can support rates of 8kHz, 11.025kHz, 12kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz, 88.2kHz, and 96kHz in 32fs/64fs/128fs/256fs.

I^2S can support rates of 8kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz, 88.2kHz, and 96kHz in 48fs.

16.5.3 HW Control Mode

In the I^2S/Left-Justify format of HW control mode, there are 2 channels per LRCK period, and the audio bits are 16bits per channel. Therefore, the audio bit of BCK periods per LRCK period in this mode is exactly 32fs.

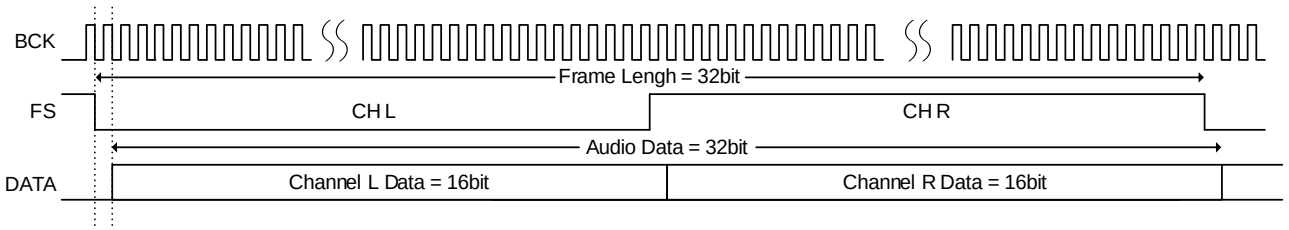

Figure 5. I^2S Format with HW Control Mode (BCK = 32fs)

According to this design concept, the audio bits are 24 bits per channel and 32 bits per channel, and the audio bits of BCK periods per LRCK period is exactly 48fs and 64fs, respectively.

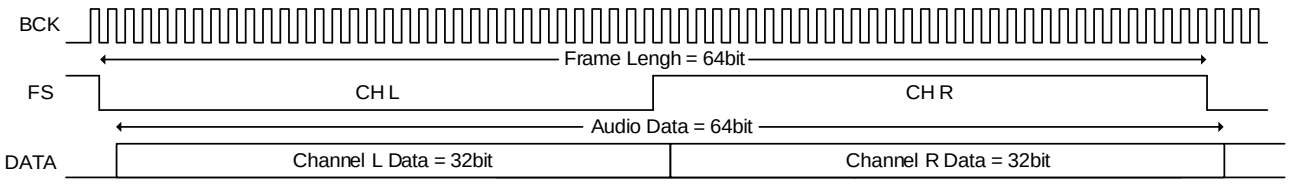

Figure 6. I^2S Format with HW Control Mode (BCK = 64fs)

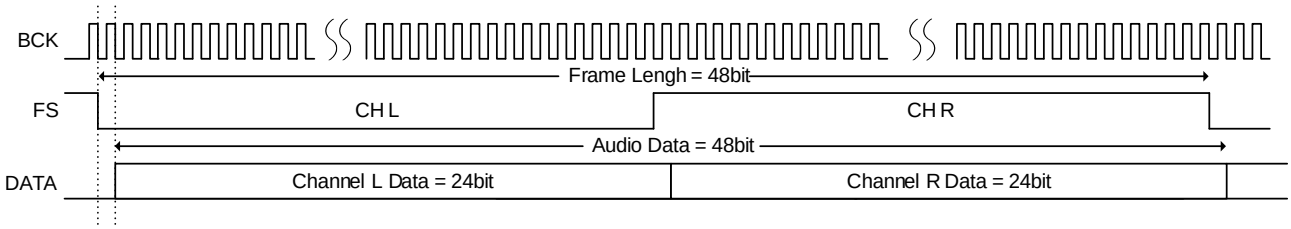

Figure 7. I^2S Format with HW Control Mode (BCK = 48fs)

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In the 4-channel TDM format of HW control mode, there are 4 channels per LRCK period, and the audio bits are 32 bits per channel. The audio bits of BCK periods per LRCK period in this mode are exactly 128fs or 256fs.

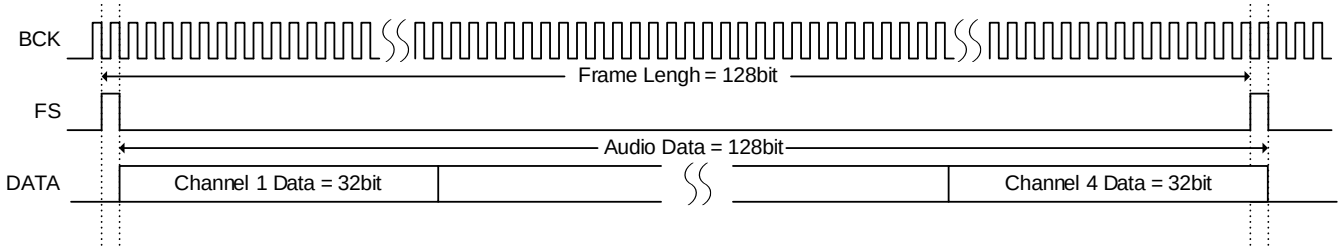

Figure 8. 4-Channel TDM with HW Control Mode (BCK = 128fs)

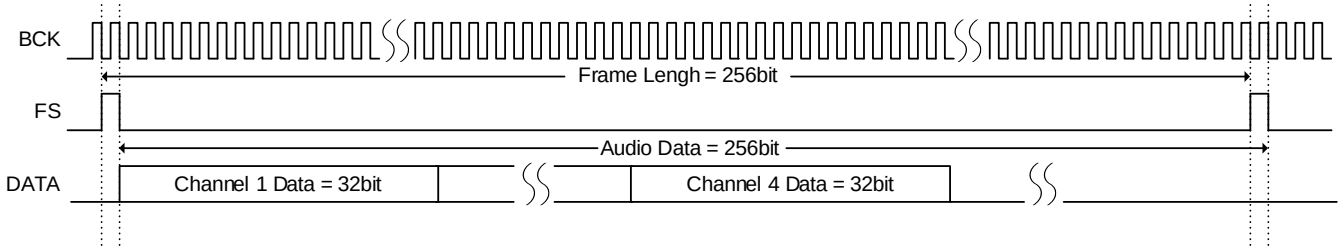

Figure 9. 4-Channel TDM with HW Control Mode (BCK = 256fs)

In the 8-channel TDM format of HW control mode, there are 8 channels per LRCK period and the audio bits are 16 bits per channel. The audio bits of BCK periods per LRCK period in this mode are exactly 128fs. There are 8-channel per LRCK period and audio bits are 32 bits per channel. The audio bits of BCK periods per LRCK period in this mode are exactly 256fs.

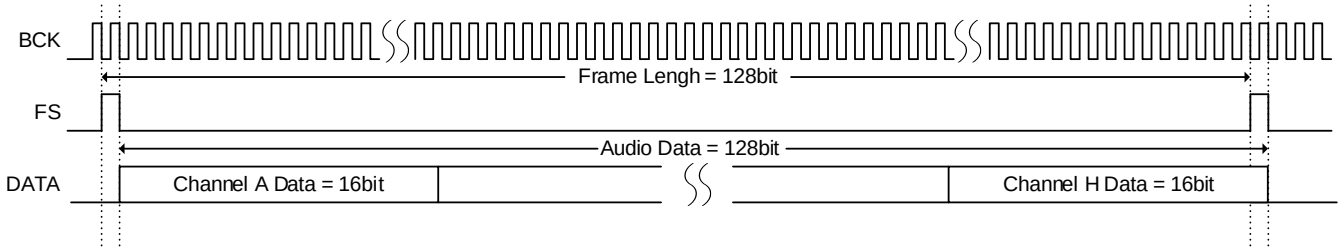

Figure 10. 8-Channel TDM with HW Control Mode (BCK = 128fs)

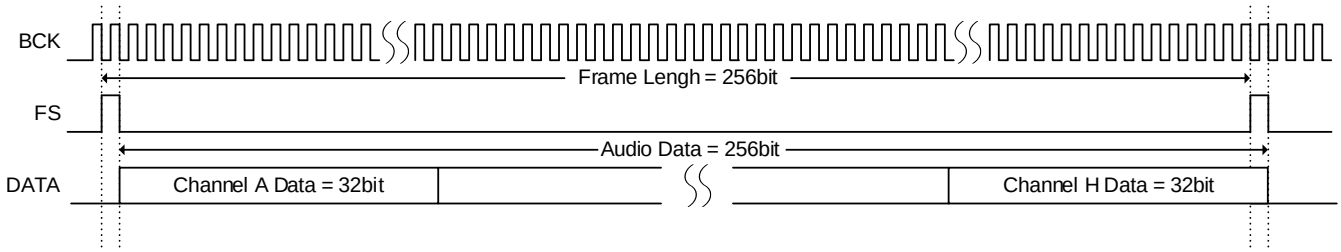

Figure 11. 8-Channel TDM with HW Control Mode (BCK = 256fs)

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Table 2. Valid Resolutions and Frame Widths

Audio Bits	BCK in I²S/Left-Justified	BCK in 4CH TDM Mode	BCK in 8CH TDM Mode
16	32fs	128fs/256fs	128fs
24	48fs	NOT VALID	NOT VALID
32	64fs	128fs/256fs	256fs

16.5.4 LRCK/BCK PIN Configuration for I²S or TDM Interface in HW Control Mode

The RT9123 will automatically detect the bit clock rate and sample rate to determine the audio source format after power-on. Valid sample rates are 8kHz, 16kHz, 24kHz, 44.1kHz, 48kHz, 88.2kHz, and 96kHz.

Table 3. Valid LRCK/BCK Frequencies (kHz)

BCK (MHz) / LRCK	I²S Mode			TDM Mode	
	32*fs	48*fs	64*fs	128*fs	256*fs
fs = 8kHz	0.256	0.384	0.512	1.024	2.048
fs = 16kHz	0.512	0.768	1.024	2.048	4.096
fs = 24kHz	0.768	1.152	1.536	3.072	6.144
fs = 32kHz	1.024	1.536	2.048	4.096	8.192
fs = 44.1kHz	1.411	2.117	2.822	5.645	11.290
fs = 48kHz	1.536	2.304	3.072	6.144	12.288
fs = 88.2kHz	2.822	4.234	5.645	11.290	22.579
fs = 96kHz	3.072	4.608	6.144	12.288	24.576

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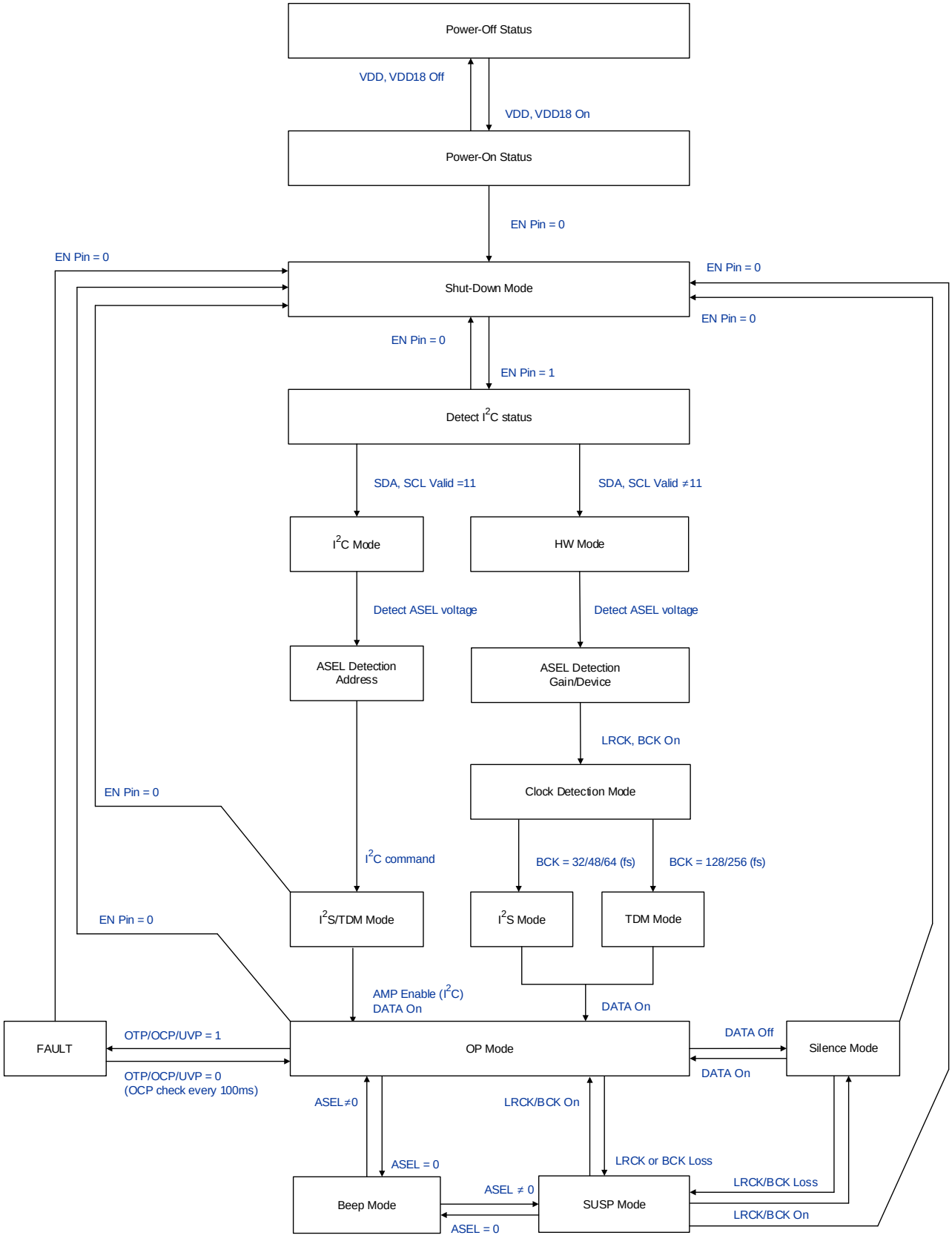
16.6 State Machine



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16.7 Protection

16.7.1 Undervoltage Protection (UVP) for V_{DD}

The undervoltage protection can detect undervoltage faults on the power supply V_{DD}. The UV flag is triggered when V_{DD} is lower than 2.2V, and then the digital control system disables the analog blocks. When V_{DD} is higher than the hysteresis UVP threshold of 2.4V, the UV protection detects the voltage again to determine if the UV event is finished.

16.7.2 Undervoltage Protection (UVP) for V_{DD18}

The undervoltage protection can detect undervoltage faults on power supply V_{DD18}. When V_{DD18} is lower than 1.4V, the UV flag is triggered, and the digital control system disables the analog blocks. When V_{DD18} is higher than the hysteresis UVP threshold of 1.6V, the UV protection detects the voltage again to determine if the UV event is finished.

16.7.3 Over-Temperature Protection (OTP)

The over-temperature protection can detect over-temperature faults in the chip. The OTP is triggered when the junction temperature is higher than 150°C, and the digital control system disables the analog blocks. When the junction temperature is lower than the hysteresis threshold 150°C, the OTP detects the temperature to determine if the OT event is finished.

16.7.4 Overcurrent Protection (OCP)

The overcurrent protection can detect overcurrent faults in the Class-D amplifier. A fault in the Class-D amplifier that causes a large current exceeding 2.8A triggers the OC flag to the digital control system and disables the analog blocks for 100ms. After a 100ms cooling period, the OCP detects the current again to determine if the OC event is finished.

16.8 Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature $T_{J(MAX)}$, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the temperature difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula:

$P_{D(MAX)} = (T_{J(MAX)} – T_A) / \theta_{JA}$

where $T_{J(MAX)}$ is the maximum junction temperature; T_A is the ambient temperature; and θ_{JA} is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance, θ_{JA}, is highly package dependent. For a WL-CSP-14B 1.81x1.1 (BSC) package, the thermal resistance, θ_{JA}, is 25.7°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. For a WDFN-12L 3x3 package, the thermal resistance, θ_{JA}, is 30.8°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at T_A = 25°C can be calculated as below:

$P_{D(MAX)}$ = (125°C – 25°C) / (25.7°C/W) = 3.89W for a WL-CSP-14B 1.81x1.1 (BSC) package.

$P_{D(MAX)}$ = (125°C – 25°C) / (30.8°C/W) = 3.24W for a WDFN-12L 3x3 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed $T_{J(MAX)}$ and the thermal resistance, θ_{JA}. The derating curves in Figure 12 allow the designer to see the effect of rising ambient temperature on the maximum power dissipation.

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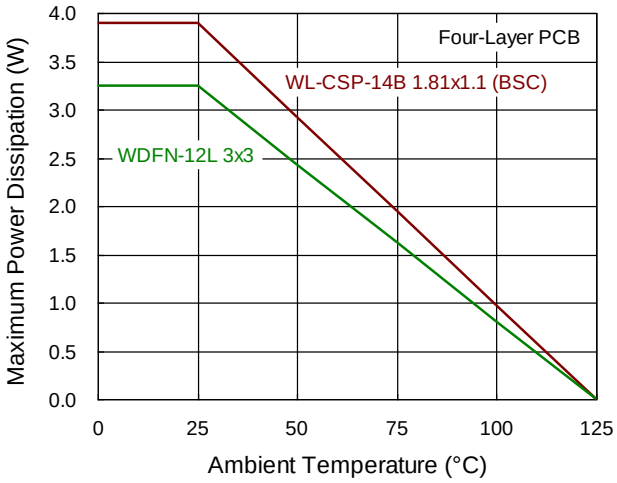
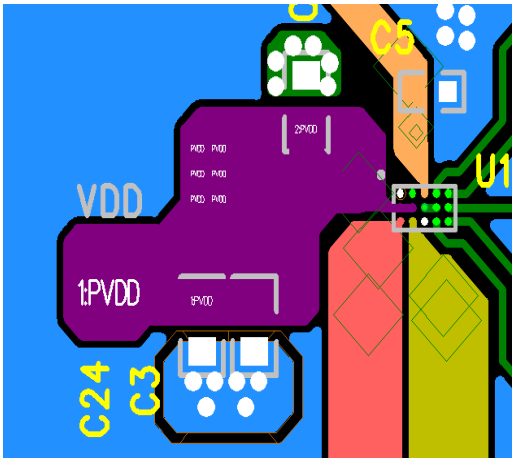


Figure 12. Derating Curves of Maximum Power Dissipation

16.9 Layout Considerations

1. To provide good grounding for the IC and ensure good audio quality while reducing the possibility of interference, power and signal paths should be separated as much as possible. Configure PGND and GND separately during layout and ensure that digital signals are not affected by analog noise.



2. Keep the analog signal paths (VDD, OUTP, and OUTN) as wide and short as possible. We recommend that each path has a minimum width to support 1.5A of current to ensure sufficient current capacity. For example, on a 1oz copper thickness PCB, we recommend reserving at least 60mil width for the AVDD and output paths.

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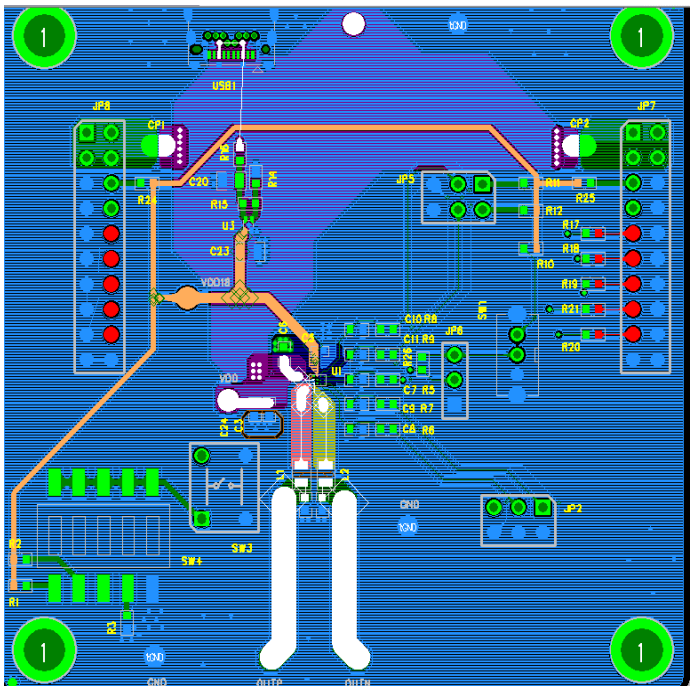
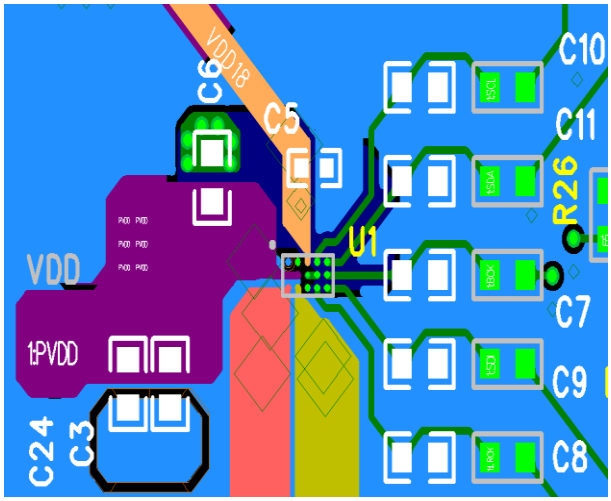


3. Place all decoupling capacitors as close to the RT9123 IC as possible to improve audio performance.



4. Ensure that I^2S and I^2C signal paths have a minimum bend angle of over 90° to avoid sharp bends that can cause antenna effects.
5. Ensure that both sides of each I^2S and I^2C signal path have grounding to prevent signal interference.

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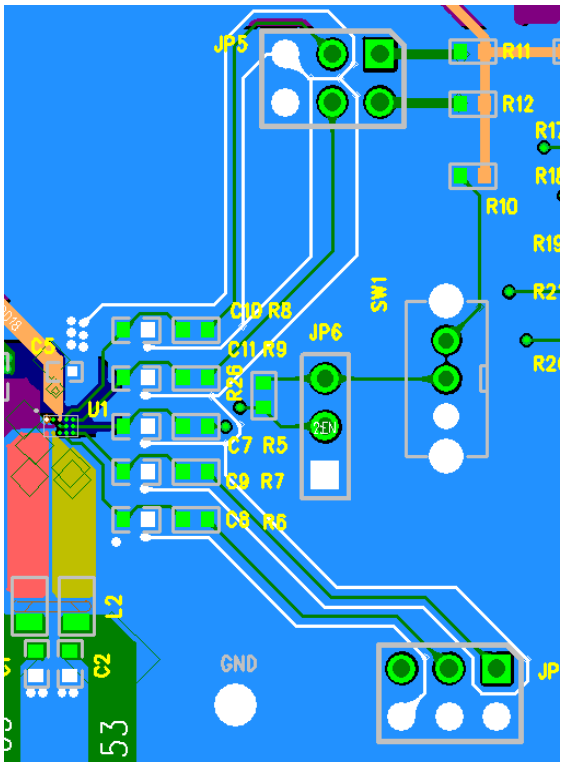

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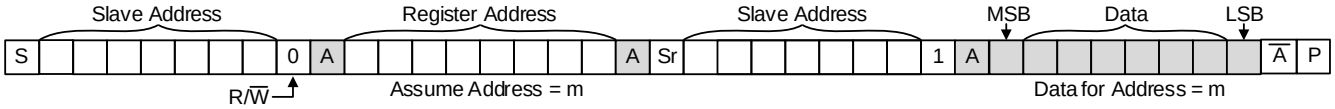
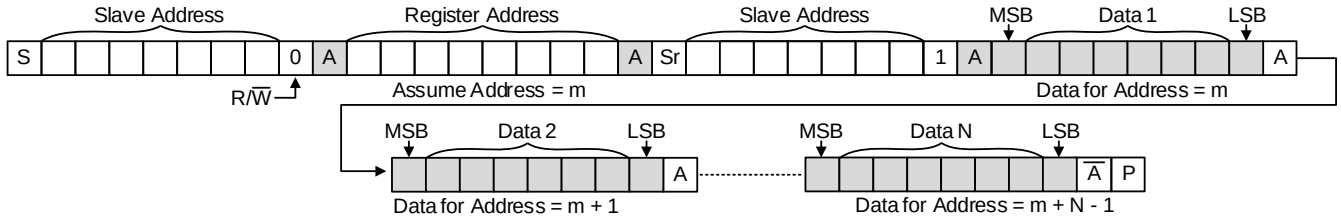
16.10 I²C Interface

16.10.1 Read and Write Function

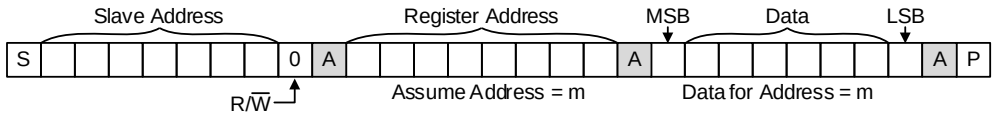
Read a single byte of data from Register



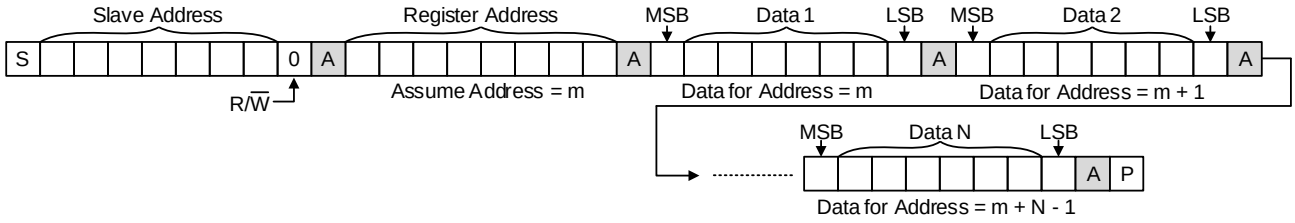
Read N bytes of data from Registers



Write a single byte of data to Register

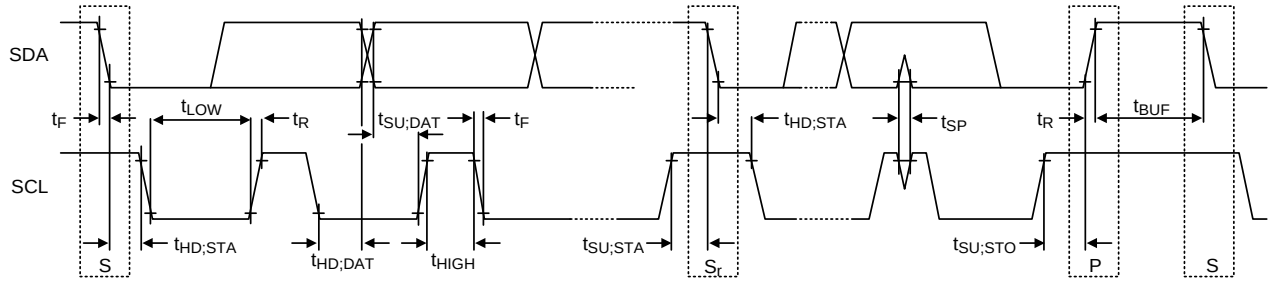


Write N bytes of data to Registers



Driven by Master, Driven by Slave, P Stop, S Start, Sr Repeat Start

16.10.1.1 I²C Waveform Information



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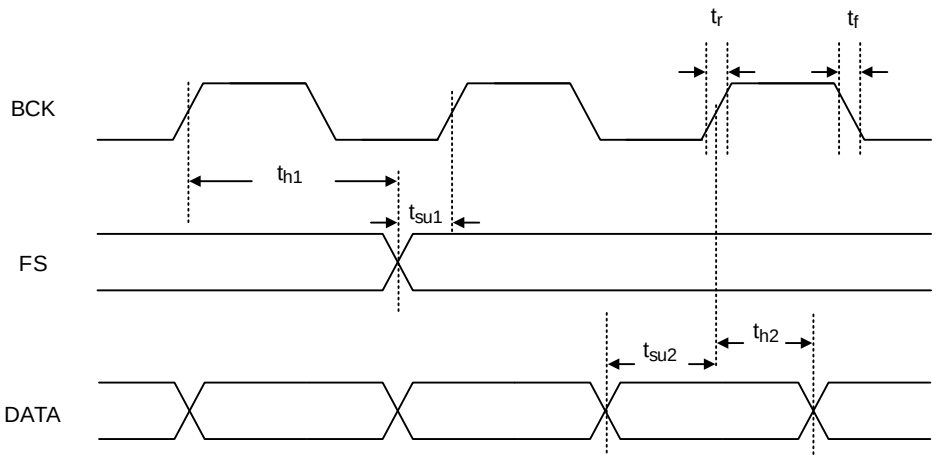
16.11 I²S Interface

16.11.1 I²S Waveform Information



Note 7. The information provided in this section is for reference only. The customer is solely responsible for designing, validating, and testing any applications incorporating Richtek's product(s). The customer is also responsible for applicable standards and any safety, security, or other requirements.

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17 Functional Register Description

Address	Byte	Bits	Bits Name	Default	Type	Description
0x00	2	15:10	Reserved	6'h0	RO	Reserved
		9:4	PROD_ID	000000'b	RO	Product ID
		3:0	VER_ID	0001'b	RO	Version ID
0x01	2	15	SF_RESET	0'b	WO	Write 1 to trigger a software reset Need to wait for 10ms for the reset to complete
		14	MUTE	0'b	RW	0: Un-mute (default) 1: Soft mute
		13	Reserved	0'b	RO	Reserved
		12	AMP_ON	0'b	RW	Enable amp 0: Amp off (I^2C mode default) (default) 1: Amp on (HW control mode default)
		11	Reserved	0'b	RO	Reserved
		10:8	SYS_STATUS	000'b	RO	System status 000: Shutdown (default) 010: Suspend mode / Standby mode 011: Silence mode 100: Beep mode (1MHz clock) 110: Operation mode 111: Beep mode (BCK clock) Others: Reserved
		7:6	Reserved	00'b	RO	Reserved
		5:4	D_TRI_FREQ_SEL	10'b	RW	PWM frequency selection 00: 300kHz 01: 325kHz 10: 350kHz (default) 11: 375kHz
		3:0	SPK_GAIN	1001'b	RW	SPK RI (GAIN) selection 0000: −12dB (DRE-on) 0001: 0dB 0010:1.5dB 0011: 3dB 0100: 4.5dB 0101: 6dB 0110: 7.5dB 0111: 9dB 1000: 10.5dB 1001: 12dB (default) Others: Reserved

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Address	Byte	Bits	Bits Name	Default	Type	Description
0x02	2	15	SCLK_EDGE_SEL	0'b	RW	0: LRCK transition align with BCK falling (default) 1: LRCK transition align with BCK rising
		14:12	AUD_BITS	010'b	RW	000: 16 bits 001: 20 bits 010: 24 bits (default) 011: 32 bits 100: 8 bits Others: Reserved
		11	TDM_DSP_OFFSET	1'b	RW	TDM or DSPM offset selection 0: Without offset (DSPMB) 1: 1 bit clock offset (DSPMA) (default)
		10:8	AUD_FMT	000'b	RW	000: I^2S (default) 001: Left-Justified 010: Right-Justified 011: DSP mode 1xx: TDM mode
		7:6	Reserved	00'b	RO	Reserved
		5:4	I2S_CH_SEL	01'b	RW	I^2S channel selection 01: L channel (default) 10: R channel 00/11: (L+R) / 2
		3:2	Reserved	00'b	RO	Reserved
		1:0	BEEP_FREQ_SEL	01'b	RW	Beep frequency selection 00: 200Hz 01: 400Hz (default) 10: 800Hz 11: 1000Hz
0x03	2	15:5	Reserved	11'h0	RW	Reserved
		4:0	TDM_RX_LOC	00000'b	RW	TDM starts receiving location selection

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Address	Byte	Bits	Bits Name	Default	Type	Description
0x04	2	15	Reserved	0'b	RW	Reserved
		14	SIL_DET_EN	0'b	RW	Silence detection enable 0: Disable (default) 1: Enable
		13:12	SIL_TH_SEL	11'b	RW	Silence mode detection threshold (in different AUD_BITS setting) Detect how much MSB swing between 0000… or FFFF… and don't care LSB toggled 00: 13MSB (16-bit)/17MSB (20-bit)/21MSB (24-bit)/25MSB (32-bit) 01: 14MSB (16-bit)/18MSB (20-bit)/22MSB (24-bit)/26MSB (32-bit) 10: 15MSB (16-bit)/19MSB (20-bit)/23MSB (24-bit)/27MSB (32-bit) 11: 16MSB (16-bit)/20MSB (20-bit)/24MSB (24-bit)/28MSB (32-bit) (default) Equivalent to the audio signal level in 32-bit audio 00: −73dB (16-bit) / −97Db (20-bit) / −121dB (24-bit) / −145dB (32-bit) 01: −79dB (16-bit) / −103dB (20-bit) / −127dB (24-bit) / −151dB (32-bit) 10: −85dB (16-bit) / −109dB (20-bit) / −133dB (24-bit) / −157dB(32-bit) 11: −91dB (16-bit) / −115dB (20-bit) / −139dB (24-bit) / −163dB (32-bit) (default)
		11:9	SIL_HOLD_TIME	010'b	RW	Silence mode hold time selection 000: 1ms 001: 20ms 010: 40ms (default) 011: 80ms 100: 160ms 101: 320ms 110: 640ms 111: 1.28s
		8	SKIP_RAMP	0'b	RW	Skip volume ramp 0: Volume ramp (default) 1: Skip volume ramp
		7:6	VOL_RAMP_MODE	00'b	RW	Volume slew step control 00: 4.33ms from mute to 0dB (0.5dB/20.83μs) (default) 01: 8.66ms from mute to 0dB (0.25dB/20.83μs) 10: 17.33ms from mute to 0dB (0.125dB/20.83μs) 11: 34.65ms from mute to 0dB (0.0625dB/20.83μs)
		5	HPF_EN	1'b	RW	High-Pass filter enable 0: Disable 1: Enable (default)
		4	DRE_EN	1'b	RW	DRE function 0: Disable 1: Enable (default)

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Address	Byte	Bits	Bits Name	Default	Type	Description
		3	HARD_CLIP_EN	0'b	RW	Hard clip enable 0: Disable (default) 1: Enable
		2	D_FSS_EN	0'b	RW	Spread spectrum enable 0: Disable (default) 1: Enable
		1	CLIP_DET_EN	1'b	RW	Clip detection enable 0: Disable 1: Enable (default)
		0	CLIP_AGC_EN	0'b	RW	Enable auto gain control for CLIP detection 0: Disable (default) 1: Enable
0x05	2	15	Reserved	0'b	RO	Reserved
		14	PWM_ MODEWHITE	0'b	RW	Noise selection 0: Pink noise (default) 1: White noise
		13	PWM_SELCOEF	0'b	RW	Pink noise coefficient This will affect the noise amplitude for spread spectrum signal, not recommended to modify it. 0: 1/2 (default) 1: 1/4
		12	PWM_NOISE_EN	0'b	RW	Add noise to TRI_GEN 0: Disable (default) 1: Enable
		11:10	D_NOISE_AMP	00'b	RW	Noise amplitude for SSC 00: 6.3% (default) 01: 11.7% 10: 17.1% 11: 35.1%
		9:8	D_FSS_AMP	01'b	RW	Spread spectrum frequency variation amplitude 00: 14.73% 01: 22.5% (default) 10: 22.5% 11: 30.35%
		7:2	Reserved	6'h0	RO	Reserved
		1	I2C_TIME_OUT_ SEL	0'b	RW	I^2C timeout reset selection 0: Reset I^2C IP only (default) 1: Reset whole chip
		0	I2C_TIME_OUT_ EN	1'b	RW	I^2C timeout function: If SDA and SCL keep low for 100ms, an I^2C timeout reset will occur. 0x05 bit 0 is the reset option to select the reset block. 0x05 bit 1 for enabling the I^2C timeout function. 0: Disable (default) 1: Enable

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Address	Byte	Bits	Bits Name	Default	Type	Description
0x12	2	15:11	Reserved	5'h0	RO	Reserved
		10:0	VOL_GAIN	11'h180	RW	Volume gain control 11'h000: 24dB 11'h180: 0dB (default) 11'h7FF: mute 0.0625dB per step
0x13	2	15:11	Reserved	5'h0	RO	Reserved
		10:0	HC_TH	11'h180	RW	Hard clip threshold when HARD_CLIP_EN = 1 > 0dB is not allowable for hard clip threshold setting. 11'h180: 0dB (default) 0.0625db per step
0x20	2	15	BCK_ERR	0'b	W0C	0: No BLK error (default) 1: BLK error, write 0 to clear flag
		14	LRCK_ERR	0'b	W0C	0: No LRCK clock error (default) 1: LRCK clock error, write 0 to clear flag
		13	UVP50	0'b	W0C	5V UVP 0: Normal (default) 1: Fault (write 0 to clear)
		12	UVP18	0'b	W0C	1.8V UVP 0: Normal (default) 1: Fault (write 0 to clear)
		11	OTP	0'b	W0C	Channel OTP 0: Normal (default) 1: Fault (write 0 to clear)
		10	OCP	0'b	W0C	Channel OCP 0: Normal (default) 1: Fault (write 0 to clear)
		9	CLIP	0'b	W0C	Clip detection 0: Normal (default) 1: Warning (write 0 to clear)
		8	MODE_ERR	0'b	W0C	Mode detection fault 0: Normal (default) 1: Warning (write 0 to clear)
		7	SR_AUTO_DET	1'b	RW	Sampling rate detection enable bit Detect sampling rate and BCK mode 0: Disable, manual set 0x01 SR mode and BCK mode 1: Enable (default)
		6:4	SR_MODE	101'b	RW	Sampling rate (manual setting or report) If auto sampling rate detection, SR_MODE reports detection result. 000: 8kHz 001: 12kHz 010: 16kHz 011: 24kHz 100: 32kHz 101: 44.1/48kHz (default) 110: 88.2/96kHz 111: Sampling rate error report

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Address	Byte	Bits	Bits Name	Default	Type	Description
		3:0	BCK_MODE	0010'b	RW	BCK mode report 0000: BCK = 32fs 0001: BCK = 48fs 0010: BCK = 64fs (default) 0100: BCK = 128fs 0110: BCK = 256fs 1001: BCK mode error report Others: Reserved
0x21	2	15	FAULT_RAMP_MUTE	0'b	RW	Signal ramp down option when fault occurred 0: Directly mute (default) 1: Ramp mute 1ms
		14	UVP50_EN	1'b	RW	5V UVP enable 0: Disable 1: Enable (default)
		13	UVP18_EN	1'b	RW	1.8V UVP enable 0: Disable 1: Enable (default)
		12	DC_UVP_CAL_EN	0'b	RW	PVDD UVP re-calibration DC offset enable 0: Disable (default) 1: Enable
		11:10	UVP_DEG_SEL	01'b	RW	UVP flag deglitch time 00: Without deglitch 01: 20μs (default) 10: 30μs 11: 40μs
		9:8	CLIP_DET_SEL	01'b	RW	Clip detect threshold, release threshold (unit: PWM cycle) 00: 4, 2 01: 8, 4 (default) 10: 16, 6 11: 32, 12
		7:6	AGC_ATTACK_RATE	10'b	RW	AGC attack time selection for AGC 00: 0.25dB/20μs 01: 0.25dB/40μs 10: 0.25dB/80μs (default) 11: 0.25dB/160μs
		5:4	AGC_RELEASE_RATE	10'b	RW	AGC release time selection for AGC 00: 0.25dB/50ms 01: 0.25dB/100ms 10: 0.25dB/200ms (default) 11: 0.25dB/400ms
		2:0	D_SPK_CLP	100'b	RW	SPK duty clamping selection 000: 20.4n 001: 24.6n 010: 26n 011: 30n 100: 31.5n (default) 101: 35.7n 110: 37n 111: 41n

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Address	Byte	Bits	Bits Name	Default	Type	Description
0x36	2	15	D_BG_OK	0'b	RO	Bandgap ready signal
		14	D_UVP50_FLAG	0'b	RO	5V undervoltage flag
		13	D_UVP18_FLAG	0'b	RO	1.8V undervoltage flag
		12	D_OT_FLAG	0'b	RO	Over-temperature flag
		11	D_OCP_FLAG	0'b	RO	SPK OCP output flag
		10:0	Reserved	020'h	RW	Reserved

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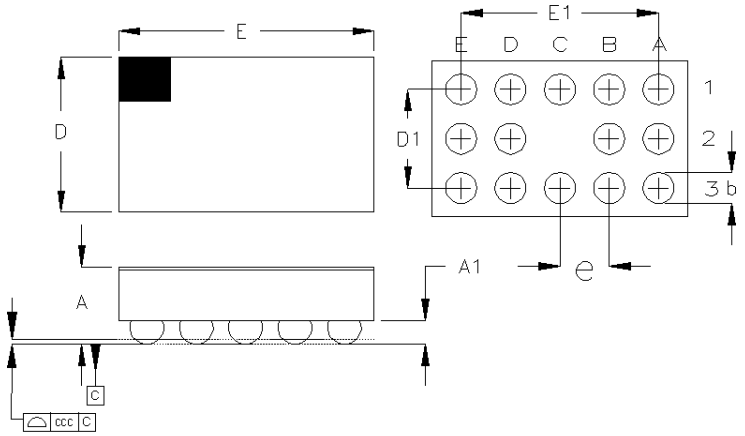
18 Outline Dimension

18.1 WL-CSP-14B 1.81x1.1 (BSC)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.500	0.600	0.020	0.024
A1	0.120	0.180	0.005	0.007
b	0.190	0.250	0.007	0.010
E	1.770	1.850	0.070	0.073
E1	1.400		0.055	
D	1.060	1.140	0.042	0.045
D1	0.700		0.028	
e	0.350		0.014	
ccc	0.020		0.001	

14B WL-CSP 1.81x1.1 Package (BSC)

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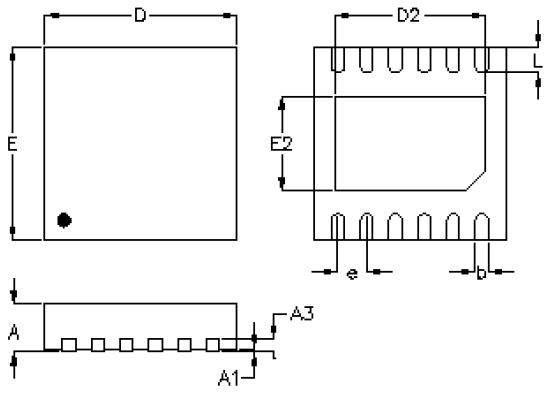
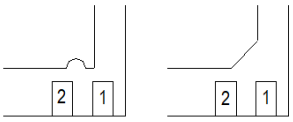
18.2 WDFN-12L 3x3





DETAIL A

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol		Dimensions In Millimeters		Dimensions In Inches	
		Min	Max	Min	Max
A		0.700	0.800	0.028	0.031
A1		0.000	0.050	0.000	0.002
A3		0.175	0.250	0.007	0.010
b		0.150	0.250	0.006	0.010
D		2.950	3.050	0.116	0.120
D2	Option1	2.300	2.650	0.091	0.104
	Option2	1.970	2.070	0.078	0.081
E		2.950	3.050	0.116	0.120
E2	Option1	1.400	1.750	0.055	0.069
	Option2	1.160	1.260	0.046	0.050
e		0.450		0.018	
L		0.350	0.450	0.014	0.018

W-Type 12L DFN 3x3 Package

Note 8. The package of the RT9123 uses Option1.

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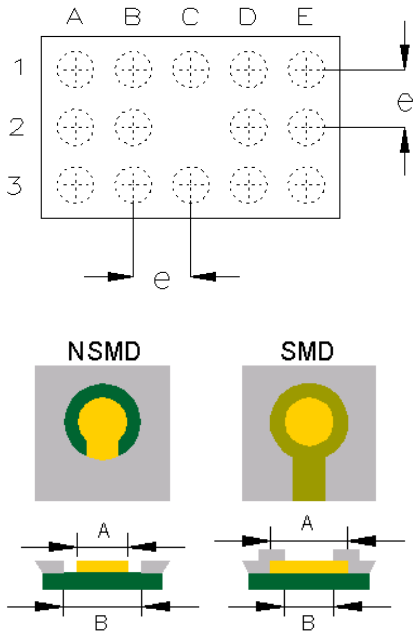
19 Footprint Information

19.1 WL-CSP-14B 1.81x1.1 (BSC)



Package	Number of Pins	Type	Footprint Dimension (mm)			Tolerance
			e	A	B	
WL-CSP1.81x1.11-14(BSC)	14	NSMD	0.350	0.200	0.300	±0.025
		SMD		0.230	0.200	

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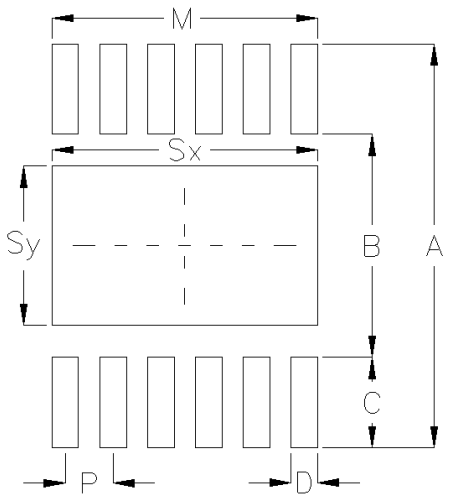
19.2 WDFN-12L 3x3



Package		Number of Pin	Footprint Dimension (mm)								Tolerance
			P	A	B	C	D	Sx	Sy	M	
V/W/U/XDFN3x3-12	Option1	12	0.45	3.80	2.10	0.85	0.25	2.50	1.50	2.50	±0.05
	Option2							2.12	1.31		

Note 9. The package of the RT9123 uses Option1.

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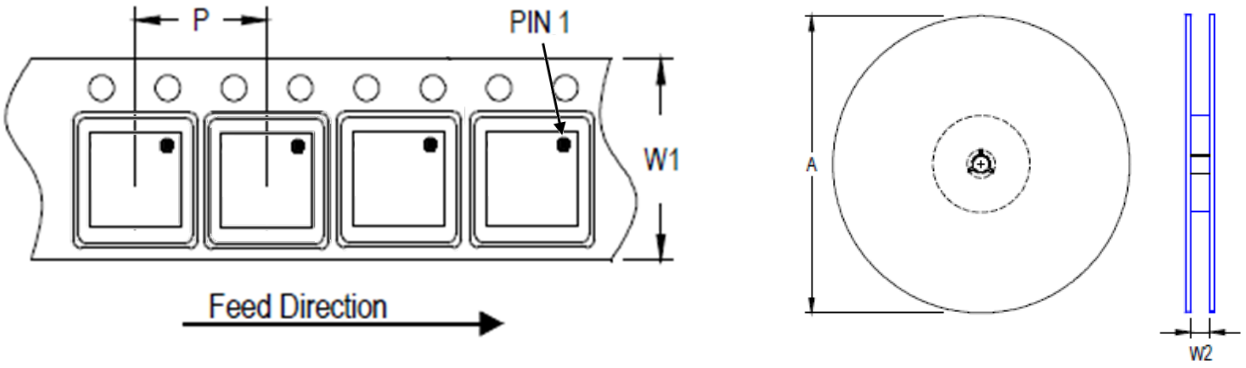
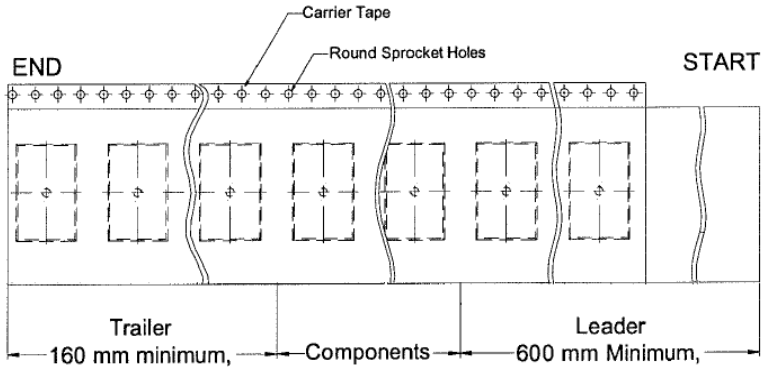
20 Packing Information

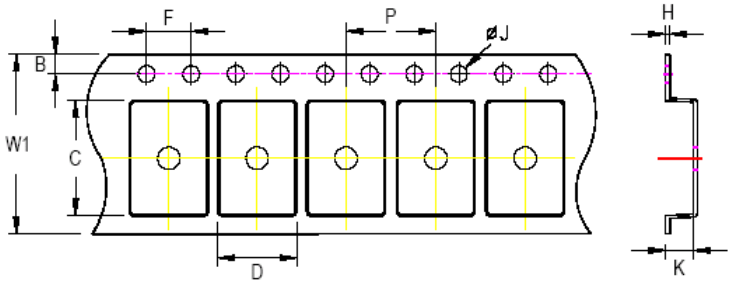
20.1 Tape and Reel Data

20.1.1 WL-CSP-14B 1.81x1.1 (BSC)





Package Type	Tape Size (W1) (mm)	Pocket Pitch (P) (mm)	Reel Size (A)		Units per Reel	Trailer (mm)	Leader (mm)	Reel Width (W2) Min/Max (mm)
			(mm)	(in)				
WL-CSP 1.81x1.1	8	4	180	7	3,000	160	600	8.4/9.9



C, D, and K are determined by component size. The clearance between the components and the cavity is as follows:

- For 8mm carrier tape: 0.5mm max.

Tape Size	W1	P		B		F		ØJ		K		H
	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Max
8mm	8.3mm	3.9mm	4.1mm	1.65mm	1.85mm	3.9mm	4.1mm	1.5mm	1.6mm	0.7mm	0.8mm	0.6mm

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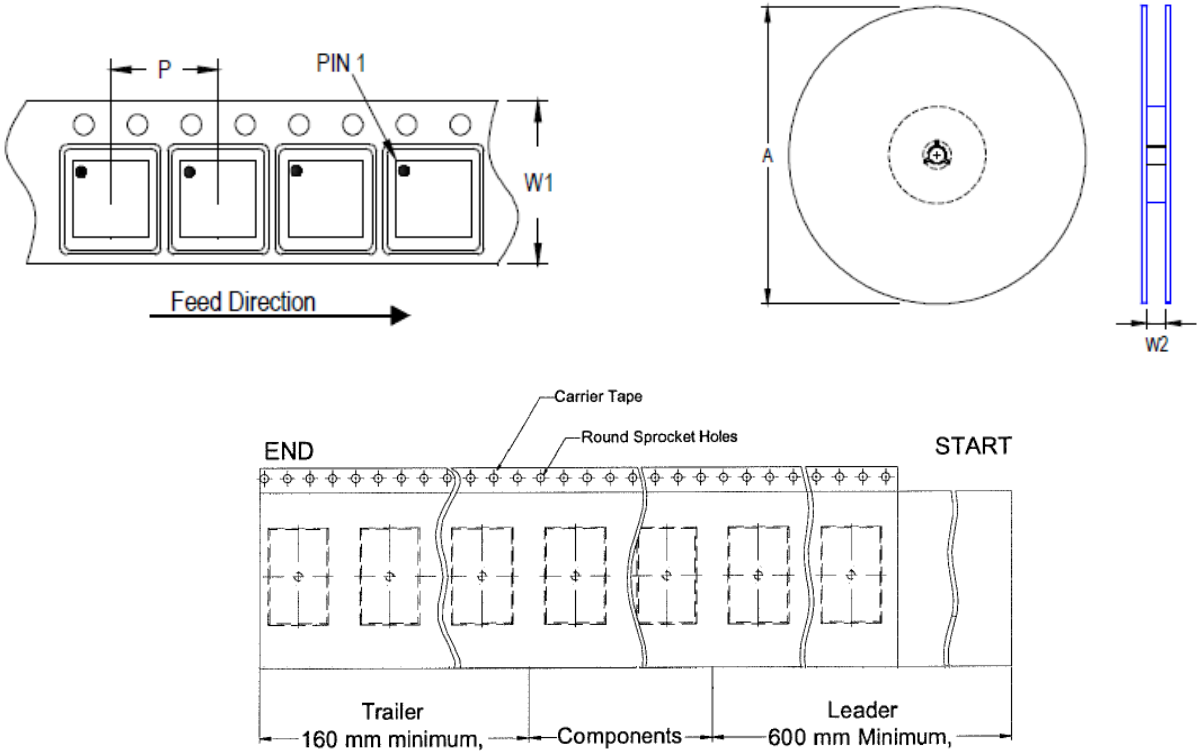
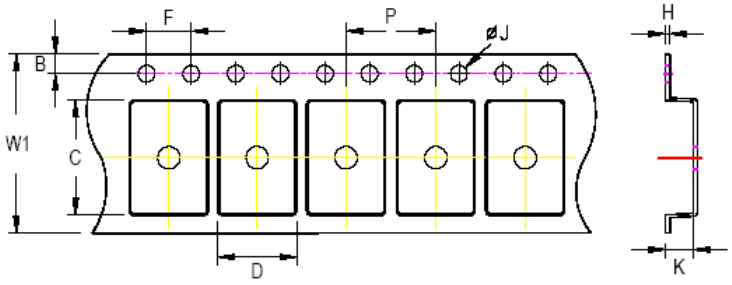
20.1.2 WDFN-12L 3x3



Package Type	Tape Size (W1) (mm)	Pocket Pitch (P) (mm)	Reel Size (A)		Units per Reel	Trailer (mm)	Leader (mm)	Reel Width (W2) Min/Max (mm)
			(mm)	(in)				
(V, W) QFN/DFN 3x3	8	4	180	7	3,000	160	600	8.4/9.9



C, D, and K are determined by component size. The clearance between the components and the cavity is as follows:

- For 8mm carrier tape: 0.5mm max.

Tape Size	W1	P		B		F		ØJ		K		H
	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Max
8mm	8.3mm	3.9mm	4.1mm	1.65mm	1.85mm	3.9mm	4.1mm	1.5mm	1.6mm	1.0mm	1.3mm	0.6mm

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20.2 Tape and Reel Packing

20.2.1 WL-CSP-14B 1.81x1.1 (BSC)

Step	Photo/Description	Step	Photo/Description
1	Reel 7”	4	12 inner boxes per outer box
2	Packing by Anti-Static Bag	5	Outer box **Carton A**
3	3 reels per inner box **Box A**	6	

Container / Package	Reel		Box			Carton		
	Size	Units	Item	Reels	Units	Item	Boxes	Unit
WL-CSP 1.81x1.1	7”	3,000	Box A	3	9,000	Carton A	12	108,000
			Box E	1	3,000	For Combined or Partial Reel.		

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20.2.2 WDFN-12L 3x3

Step	Photo/Description	Step	Photo/Description
1	Reel 7”	4	3 reels per inner box **Box A**
2	HIC & Desiccant (1 Unit) inside	5	12 inner boxes per outer box
3	Caution label is on backside of Al bag	6	Outer box **Carton A**

Container / Package	Reel		Box			Carton		
	Size	Units	Item	Reels	Units	Item	Boxes	Unit
(V, W) QFN & DFN 3x3	7”	3,000	Box A	3	9,000	Carton A	12	108,000
			Box E	1	3,000	For Combined or Partial Reel.		

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20.3 Packing Material Anti-ESD Property

Surface Resistance	Aluminum Bag	Reel	Cover tape	Carrier tape	Tube	Protection Band
Ω/cm^2	**10^4 to 10^{11}**	**10^4 to 10^{11}**	**10^4 to 10^{11}**	**10^4 to 10^{11}**	**10^4 to 10^{11}**	**10^4 to 10^{11}**

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21 Datasheet Revision History

Version	Date	Description	Item
00	2024/5/28	Final	*Title on P1* *Features on P1* *Ordering Information on P2* *Functional Pin Description on P4* *Electrical Characteristics on P8* *Application Information on P22, 36* *Packing Information on P50, 51*
01	2025/3/14	Modify	*Features on page 1* - Added 50μA Quiescent Current in Silence Mode *RT9123 Version Table on page 2* - Updated the table *Marking Information on page 2, 3* - Updated marking information *Application Information on page 22, 23, 35* - Modified Power-On/Off Sequence - Modified description in section 16.9 *Functional Register Description on page 40* - Modified skip_ramp *Packing Information on page 50, 51* - Updated Tape and Reel Data
02	2025/3/26	Modify	*Footprint Information on page 49* - Updated WL-CSP-14B 1.81x1.1 (BSC) footprint information

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